Features

- High-performance, Low-power 8/16-bit Atmel[®] AVR[®] XMEGA[™] Microcontroller
- Non-Volatile Program and Data Memories
 - 64K 384K Bytes of In-System Self-Programmable Flash
 - 4K 8K Bytes Boot Section with Independent Lock Bits
 - 2 KB 4 KB EEPROM
 - 4 KB 32 KB Internal SRAM
 External Bus Interface for up to 16M bytes SRAM
 External Bus Interface for up to 128M bit SDRAM
- Peripheral Features
 - Four-channel DMA Controller with support for external requests
 - Eight-channel Event System
 - Eight 16-bit Timer/Counters
 - Four Timer/Counters with 4 Output Compare or Input Capture channels Four Timer/Counters with 2 Output Compare or Input Capture channels High-Resolution Extension on all Timer/Counters Advanced Waveform Extension on two Timer/Counters
 - Eight USARTs
 - IrDA modulation/demodulation for one USART
 - Four Two-Wire Interfaces with dual address match (I²C and SMBus compatible)
 - Four SPI (Serial Peripheral Interface) peripherals
 - AES and DES Crypto Engine
 - 16-bit Real Time Counter with separate Oscillator
 - Two Eight-channel, 12-bit, 2 Msps Analog to Digital Converters
 - Two Two-channel, 12-bit, 1 Msps Digital to Analog Converters
 - Four Analog Comparators with Window compare function
 - External Interrupts on all General Purpose I/O pins
 - Programmable Watchdog Timer with Separate On-chip Ultra Low Power Oscillator
- Special Microcontroller Features
 - Power-on Reset and Programmable Brown-out Detection
 - Internal and External Clock Options with PLL and Prescaler
 - Programmable Multi-level Interrupt Controller
 - Sleep Modes: Idle, Power-down, Standby, Power-save, Extended Standby
 - Advanced Programming, Test and Debugging Interfaces
 JTAG (IEEE 1149.1 Compliant) Interface for programming, test and debugging

PDI (Program and Debug Interface) for programming and debugging

- I/O and Packages
 - 78 Programmable I/O Lines
 - 100 lead TQFP
 - 100 ball CBGA
 - 100 ball VFBGA
- Operating Voltage
 1.6 3.6V
- Speed performance
 - 0 12 MHz @ 1.6 3.6V
 - 0 32 MHz @ 2.7 3.6V

Typical Applications

- Industrial control
- Factory automation
- Building control
- Board control
- White Goods
- NetworkingOptical

ZigBee

Climate control

Motor control

- Hand-held battery applications
- Power tools
- HVAC
- Metering
- Medical Applications





8/16-bit **AVR**[®] XMEGA A1 Microcontroller

ATxmega384A1 ATxmega256A1 ATxmega192A1 ATxmega128A1 ATxmega64A1

Preliminary

Downloaded from Elcodis.com electronic components distributor

Ordering Information 1.

Ordering Code	Flash (B)	E ²	SRAM	Speed (MHz)	Power Supply	Package ⁽¹⁾⁽²⁾⁽³⁾	Temp
ATxmega384A1-AU	384K + 8K	4 KB	32 KB	32	1.6 - 3.6V		
ATxmega256A1-AU	256K + 8K	4 KB	16 KB	32	1.6 - 3.6V		
ATxmega192A1-AU	192K + 8K	2 KB	16 KB	32	1.6 - 3.6V	100A	
ATxmega128A1-AU	128K + 8K	2 KB	8 KB	32	1.6 - 3.6V		
ATxmega64A1-AU	64K + 4K	2 KB	4 KB	32	1.6 - 3.6V	-	
ATxmega384A1-CU	384K + 8K	4 KB	32 KB	32	1.6 - 3.6V		-40°C - 85°C
ATxmega256A1-CU	256K + 8K	4 KB	16 KB	32	1.6 - 3.6V		-40 C - 65 C
ATxmega192A1-CU	192K + 8K	2 KB	16 KB	32	1.6 - 3.6V	100C1	
ATxmega128A1-CU	128K + 8K	2 KB	8 KB	32	1.6 - 3.6V		
ATxmega64A1-CU	64K + 4K	2 KB	4 KB	32	1.6 - 3.6V		
ATxmega128A1-C7U	128K + 8K	2 KB	8 KB	32	1.6 - 3.6V	100C2	
ATxmega64A1-C7U	64K + 4K	2 KB	4 KB	32	1.6 - 3.6V	10002	

Notes:

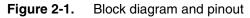
This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information.
 Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 For packaging information, see "Packaging information" on page 64.

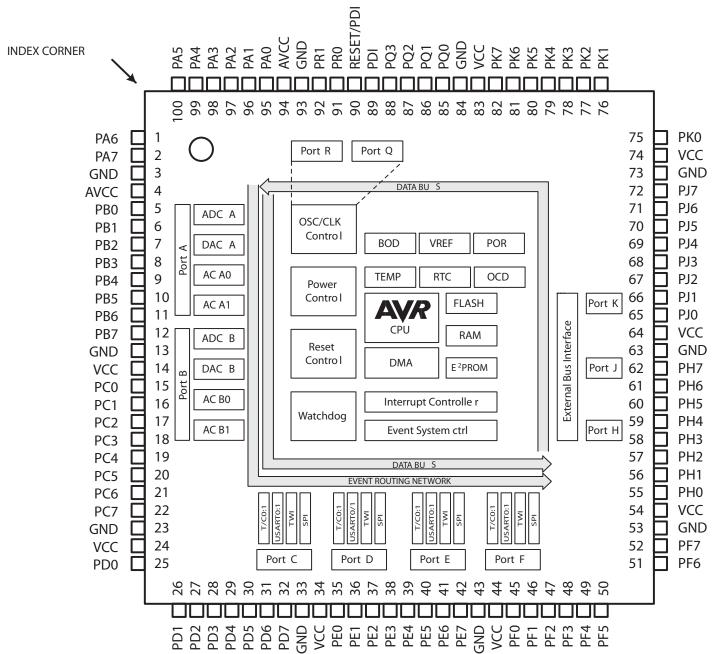
	Package Type						
100A	100-lead, 14 x 14 x 1.0 mm, 0.5 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)						
100C1	100-ball, 9 x 9 x 1.2 mm Body, Ball Pitch 0.88 mm, Chip Ball Grid Array (CBGA)						
100C2	100-ball, 7 x 7 x 1.0 mm Body, Ball Pitch 0.65 mm, Very Thin Fine-Pitch Ball Grid Array (VFBGA)						



8067M-AVR-09/10

2. Pinout/Block Diagram





Notes: 1. For full details on pinout and pin functions refer to "Pinout and Pin Functions" on page 49.

2. VCC/GND on pin 83/84 are swapped compared to other VCC/GND to allow easier routing of GND to 32 kHz crystal.



XMEGA A1

Figure 2-2. CBGA-pinout

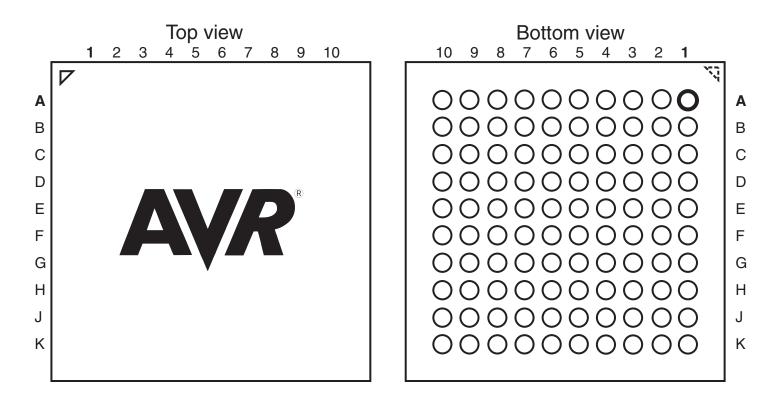


Table 2-1.CBGA-pinout

	1	2	3	4	5	6	7	8	9	10
Α	PK0	VCC	GND	PJ3	VCC	GND	PH1	GND	VCC	PF7
В	PK3	PK2	PK1	PJ4	PH7	PH4	PH2	PH0	PF6	PF5
С	VCC	PK5	PK4	PJ5	PJ0	PH5	PH3	PF2	PF3	VCC
D	GND	PK6	PK7	PJ6	PJ1	PH6	PF0	PF1	PF4	GND
Е	PQ0	PQ1	PQ2	PJ7	PJ2	PE7	PE6	PE5	PE4	PE3
F	PR1	PR0	RESET/ PDI	PDI	PQ3	PC2	PE2	PE1	PE0	VCC
G	GND	PA1	PA4	PB3	PB4	PC1	PC6	PD7	PD6	GND
Н	AVCC	PA2	PA5	PB2	PB5	PC0	PC5	PD5	PD4	PD3
J	PA0	PA3	PB0	PB1	PB6	PC3	PC4	PC7	PD2	PD1
К	PA6	PA7	GND	AVCC	PB7	VCC	GND	VCC	GND	PD0



3. Overview

The Atmel[®] AVR[®] XMEGA[™] A1 is a family of low power, high performance and peripheral rich CMOS 8/16-bit microcontrollers based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the XMEGA A1 achieves throughputs approaching 1 Million Instructions Per Second (MIPS) per MHz allowing the system designer to optimize power consumption versus processing speed.

The AVR CPU combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction, executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs many times faster than conventional single-accumulator or CISC based microcontrollers.

The XMEGA A1 devices provides the following features: In-System Programmable Flash with Read-While-Write capabilities, Internal EEPROM and SRAM, four-channel DMA Controller, eight-channel Event System, Programmable Multi-level Interrupt Controller, 78 general purpose I/O lines, 16-bit Real Time Counter (RTC), eight flexible 16-bit Timer/Counters with compare modes and PWM, eight USARTs, four Two Wire Serial Interfaces (TWIs), four Serial Peripheral Interfaces (SPIs), AES and DES crypto engine, two 8-channel, 12-bit ADCs with optional differential input with programmable gain, two 2-channel, 12-bit DACs, four analog comparators with window mode, programmable Watchdog Timer with seperate Internal Oscillator, accurate internal oscillators with PLL and prescaler and programmable Brown-Out Detection.

The Program and Debug Interface (PDI), a fast 2-pin interface for programming and debugging, is available. The devices also have an IEEE std. 1149.1 compliant JTAG test interface, and this can also be used for On-chip Debug and programming.

The XMEGA A1 devices have five software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, DMA Controller, Event System, Interrupt Controller and all peripherals to continue functioning. The Power-down mode saves the SRAM and register contents but stops the oscillators, disabling all other functions until the next TWI or pin-change interrupt, or Reset. In Power-save mode, the asynchronous Real Time Counter continues to run, allowing the application to maintain a timer base while the rest of the device is sleeping. In Standby mode, the Crystal/Resonator Oscillator is kept running while the rest of the device is sleeping. This allows very fast start-up from external crystal combined with low power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run. To further reduce power consumption, the peripheral clock to each individual peripheral can optionally be stopped in Active mode and Idle sleep mode.

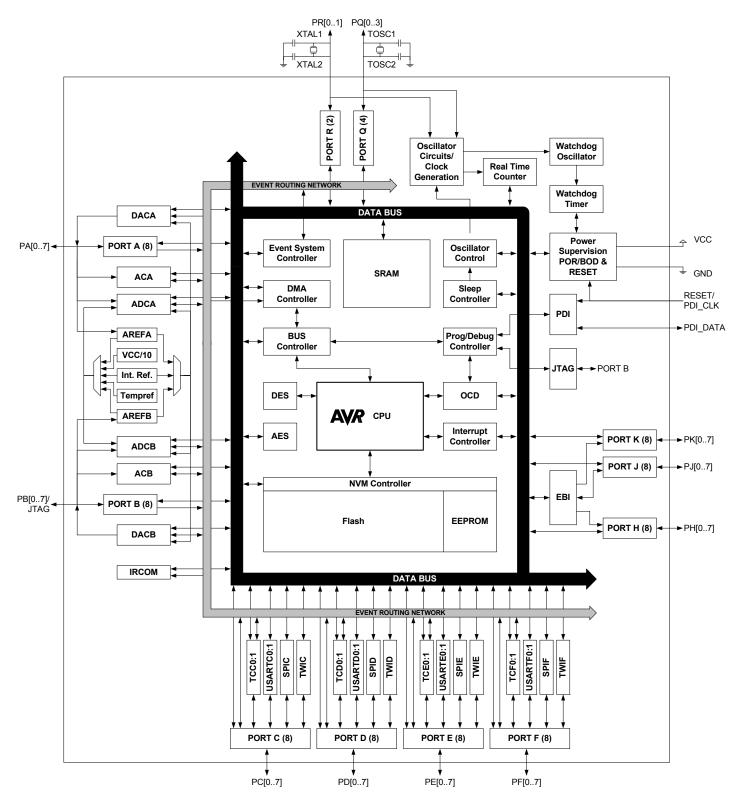
The device is manufactured using Atmel's high-density nonvolatile memory technology. The program Flash memory can be reprogrammed in-system through the PDI or JTAG. A Bootloader running in the device can use any interface to download the application program to the Flash memory. The Bootloader software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8/16-bit RISC CPU with In-System Self-Programmable Flash, the Atmel XMEGA A1 is a powerful microcontroller family that provides a highly flexible and cost effective solution for many embedded applications.

The XMEGA A1 devices are supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, programmers, and evaluation kits.



3.1 Block Diagram







4. Resources

A comprehensive set of development tools, application notes and datasheets are available for download on http://www.atmel.com/avr.

4.1 Recommended reading

- XMEGA A Manual
- XMEGA A Application Notes

This device data sheet only contains part specific information and a short description of each peripheral and module. The XMEGA A Manual describes the modules and peripherals in depth. The XMEGA A application notes contain example code and show applied use of the modules and peripherals.

The XMEGA A Manual and Application Notes are available from http://www.atmel.com/avr.

5. Disclaimer

For devices that are not available yet, typical values contained in this datasheet are based on simulations and characterization of other AVR XMEGA microcontrollers manufactured on the same process technology. Min. and Max values will be available after the device is characterized.



6. AVR CPU

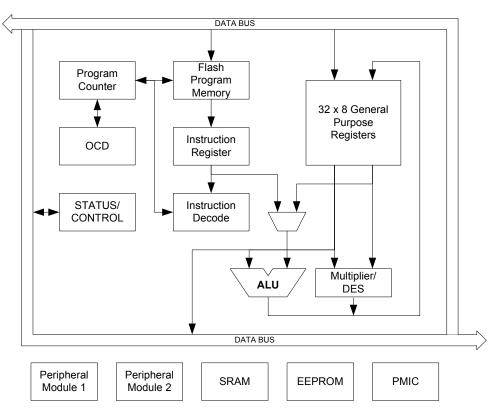
6.1 Features

- 8/16-bit high performance AVR RISC Architecture
 - 138 instructions
 - Hardware multiplier
- 32x8-bit registers directly connected to the ALU
- Stack in SRAM
- Stack Pointer accessible in I/O memory space
- Direct addressing of up to 16M Bytes of program and data memory
- True 16/24-bit access to 16/24-bit I/O registers
- Support for 8-, 16- and 32-bit Arithmetic
- Configuration Change Protection of system critical features

6.2 Overview

The XMEGA A1 uses the 8/16-bit AVR CPU. The main function of the CPU is program execution. The CPU must therefore be able to access memories, perform calculations and control peripherals. Interrupt handling is described in a separate section. Figure 6-1 on page 8 shows the CPU block diagram.





The AVR uses a Harvard architecture - with separate memories and buses for program and data. Instructions in the program memory are executed with a single level pipeline. While one instruction is being executed, the next instruction is pre-fetched from the program memory. This



concept enables instructions to be executed in every clock cycle. The program memory is In-System Self-Programmable Flash memory.

6.3 Register File

The fast-access Register File contains 32 x 8-bit general purpose working registers with single clock cycle access time. This allows single-cycle Arithmetic Logic Unit (ALU) operation. In a typical ALU cycle, the operation is performed on two Register File operands, and the result is stored back in the Register File.

Six of the 32 registers can be used as three 16-bit address register pointers for data space addressing - enabling efficient address calculations. One of these address pointers can also be used as an address pointer for look up tables in Flash program memory.

6.4 ALU - Arithmetic Logic Unit

The high performance Arithmetic Logic Unit (ALU) supports arithmetic and logic operations between registers or between a constant and a register. Single register operations can also be executed. Within a single clock cycle, arithmetic operations between general purpose registers or between a register and an immediate are executed. After an arithmetic or logic operation, the Status Register is updated to reflect information about the result of the operation.

The ALU operations are divided into three main categories – arithmetic, logical, and bit-functions. Both 8- and 16-bit arithmetic is supported, and the instruction set allows for efficient implementation of 32-bit aritmetic. The ALU also provides a powerful multiplier supporting both signed and unsigned multiplication and fractional format.

6.5 Program Flow

When the device is powered on, the CPU starts to execute instructions from the lowest address in the Flash Program Memory '0'. The Program Counter (PC) addresses the next instruction to be fetched. After a reset, the PC is set to location '0'.

Program flow is provided by conditional and unconditional jump and call instructions, capable of addressing the whole address space directly. Most AVR instructions use a 16-bit word format, while a limited number uses a 32-bit format.

During interrupts and subroutine calls, the return address PC is stored on the Stack. The Stack is effectively allocated in the general data SRAM, and consequently the Stack size is only limited by the total SRAM size and the usage of the SRAM. After reset the Stack Pointer (SP) points to the highest address in the internal SRAM. The SP is read/write accessible in the I/O memory space, enabling easy implementation of multiple stacks or stack areas. The data SRAM can easily be accessed through the five different addressing modes supported in the AVR CPU.



7. Memories

7.1 Features

- Flash Program Memory
 - One linear address space
 - In-System Programmable
 - Self-Programming and Bootloader support
 - Application Section for application code
 - Application Table Section for application code or data storage
 - Boot Section for application code or bootloader code
 - Separate lock bits and protection for all sections
 - Built in fast CRC check of a selectable flash program memory section
- Data Memory
 - One linear address space
 - Single cycle access from CPU
 - SRAM
 - EEPROM
 - Byte and page accessible
 - Optional memory mapping for direct load and store
 - I/O Memory
 - Configuration and Status registers for all peripherals and modules 16 bit-accessible General Purpose Register for global variables or flags
 - External Memory support
 - SRAM
 - SDRAM

Memory mapped external hardware

- Bus arbitration
 - Safe and deterministic handling of CPU and DMA Controller priority
- Separate buses for SRAM, EEPROM, I/O Memory and External Memory access Simultaneous bus access for CPU and DMA Controller
- Production Signature Row Memory for factory programmed data
 - Device ID for each microcontroller device type
 - Serial number for each device
 - Oscillator calibration bytes
 - ADC, DAC and temperature sensor calibration data
- User Signature Row
 - One flash page in size Can be read and written from software
 - Content is kept after chip erase

7.2 Overview

The AVR architecture has two main memory spaces, the Program Memory and the Data Memory. In addition, the XMEGA A1 features an EEPROM Memory for non-volatile data storage. All three memory spaces are linear and require no paging. The available memory size configurations are shown in "Ordering Information" on page 2. In addition each device has a Flash memory signature row for calibration data, device identification, serial number etc.

Non-volatile memory spaces can be locked for further write or read/write operations. This prevents unrestricted access to the application software.



7.3 In-System Programmable Flash Program Memory

The XMEGA A1 devices contain On-chip In-System Programmable Flash memory for program storage, see Figure 7-1 on page 11. Since all AVR instructions are 16- or 32-bits wide, each Flash address location is 16 bits.

The Program Flash memory space is divided into Application and Boot sections. Both sections have dedicated Lock Bits for setting restrictions on write or read/write operations. The Store Program Memory (SPM) instruction must reside in the Boot Section when used to write to the Flash memory.

A third section inside the Application section is referred to as the Application Table section which has separate Lock bits for storage of write or read/write protection. The Application Table section can be used for storing non-volatile data or application software.

Figure 7-1. Flash Program Memory (Hexadecimal address)

		N N	Vorc	Address	5				
								0	Application Section (Bytes) (384K/256K/192K/128K/64K)
2EFFF	/	1EFFF	/	16FFF	/	EFFF	/	77FF	
2F000	/	1F000	/	17000	/	F000	/	7800	Application Table Section (Bytes)
2FFFF	/	1FFFF	/	17FFF	/	FFFF	/	7FFF	(8K/8K/8K/8K/4K)
30000	/	20000	/	18000	/	10000	/	8000	Boot Section (Bytes)
30FFF	/	20FFF	/	18FFF	/	10FFF	/	87FF	(8K/8K/8K/8K/4K)

The Application Table Section and Boot Section can also be used for general application software.

7.4 Data Memory

The Data Memory consists of the I/O Memory, EEPROM and SRAM memories, all within one linear address space, see Figure 7-2 on page 11. To simplify development, the memory map for all devices in the family is identical and with empty, reserved memory space for smaller devices.

Figure 7-2. Data Memory Map (Hexadecimal address)

Byte Address	ATxmega192A1	Byte Address	ATxmega128A1	Byte Address	ATxmega64A1
0	I/O Registers	0	I/O Registers	0	I/O Registers
FFF	(4 KB)	FFF	(4 KB)	FFF	(4 KB)
1000	EEPROM	1000	EEPROM	1000	EEPROM
17FF	(2 KB)	17FF	(2 KB)	17FF	(2 KB)
	RESERVED		RESERVED		RESERVED



XMEGA A1

Figure 7-2. Data Memory Map (Hexadecimal address)

		,			
2000 5FFF	Internal SRAM (16 KB)	2000 3FFF	Internal SRAM (8 KB)	2000 2FFF	Internal SRAM (4 KB)
5111	()	5111	(0.12)	2111	(=)
6000	External Memory	4000	External Memory	3000	External Memory
FFFFFF	(0 to 16 MB)	FFFFF	(0 to 16 MB)	FFFFF	(0 to 16 MB)
-					
		Byte Address	ATxmega384A1	Byte Address	ATxmega256A1
		0	I/O Registers	0	I/O Registers
		FFF	(4 KB)	FFF	(4 KB)
		1000		1000	
			EEPROM		EEPROM
			(4 KB)		(4 KB)
		1FFF		1FFF	
		2000	Internal SRAM	2000	Internal SRAM
		9FFF	(32 KB)	5FFF	(16 KB)
		10000	External Memory	6000	External Memory
		FFFFF	(0 to 16 MB)	FFFFF	(0 to 16 MB)

7.4.1 I/O Memory

All peripherals and modules are addressable through I/O memory locations in the data memory space. All I/O memory locations can be accessed by the Load (LD/LDS/LDD) and Store (ST/STS/STD) instructions, transferring data between the 32 general purpose registers in the CPU and the I/O Memory.

The IN and OUT instructions can address I/O memory locations in the range 0x00 - 0x3F directly.

I/O registers within the address range 0x00 - 0x1F are directly bit-accessible using the SBI and CBI instructions. The value of single bits can be checked by using the SBIS and SBIC instructions on these registers.

The I/O memory address for all peripherals and modules in XMEGA A1 is shown in the "Peripheral Module Address Map" on page 58.

7.4.2 SRAM Data Memory

The XMEGA A1 devices has internal SRAM memory for data storage.

7.4.3 EEPROM Data Memory

The XMEGA A1 devices have internal EEPROM memory for non-volatile data storage. It is addressable either in a separate data space or it can be memory mapped into the normal data memory space. The EEPROM memory supports both byte and page access.



7.4.4 EBI - External Bus Interface

- Supports SRAM up to
 - 512K Bytes using 2-port EBI
 - 16M Bytes using 3-port EBI
- Supports SDRAM up to
 - 128M bit using 3-port EBI
- Four software configurable Chip Selects
- Software configurable Wait State insertion
- Clocked from the Peripheral 2x Clock at up to two times the CPU clock speed

The External Bus Interface (EBI) is the interface for connecting external peripheral and memory to the data memory space. The XMEGA A1 has 3 ports that can be used for the EBI. It can interface external SRAM, SDRAM, and/or peripherals such as LCD displays and other memory mapped devices.

The address space, and the number of pins used, for the external memory is selectable from 256 bytes (8-bit) and up to 16M bytes (24-bit). Various multiplexing modes for address and data lines can be selected for optimal use of pins when more or less pins is available for the EBI.

Each of the four chip selects has seperate configuration, and can be configured for SRAM, SRAM Low Pin Count (LPC) or SDRAM. The data memory address space associated for each chip select is decided by a configurable base address and address size for each chip celect.

For SDRAM both 4-bit SDRAM is supported, and SDRAM configurations such as CAS Latency and Refresh rate is configurable in software.

The EBI is clocked from the Peripheral 2x Clock, running up to two times faster than the CPU and supporting speeds of up to 64 MHz.



7.5 Production Signature Row

The Production Signature Row is a separate memory section for factory programmed data. It contains calibration data for functions such as oscillators and analog modules.

The production signature row also contains a device ID that identify each microcontroller device type, and a serial number that is unique for each manufactured device. The device ID for the available XMEGA A1 devices is shown in Table 7-1 on page 14. The serial number consist of the production LOT number, wafer number, and wafer coordinates for the device.

The production signature row can not be written or erased, but it can be read from both application software and external programming.

Device		Device ID bytes	
	Byte 2	Byte 1	Byte 0
ATxmega64A1	4E	96	1E
ATxmega128A1	4C	97	1E
ATxmega192A1	4E	97	1E
ATxmega256A1	46	98	1E
ATxmega384A1	TBD	TBD	TBD

Table 7-1. Device ID bytes for XMEGA A1 devices.

7.6 User Signature Row

The User Signature Row is a separate memory section that is fully accessible (read and write) from application software and external programming. The user signature row is one flash page in size, and is meant for static user parameter storage, such as calibration data, custom serial numbers or identification numbers, random number seeds etc. This section is not erased by Chip Erase commands that erase the Flash, and requires a dedicated erase command. This ensures parameter storage during multiple program/erase session and on-chip debug sessions.



7.7 Flash and EEPROM Page Size

The Flash Program Memory and EEPROM data memory is organized in pages. The pages are word accessible for the Flash and byte accessible for the EEPROM.

Table 7-2 on page 15 shows the Flash Program Memory organization. Flash write and erase operations are performed on one page at a time, while reading the Flash is done one byte at a time. For Flash access the Z-pointer (Z[m:n]) is used for addressing. The most significant bits in the address (FPAGE) gives the page number and the least significant address bits (FWORD) gives the word in the page.

Devices	Flash	Page Size	FWORD	FPAGE	Application		Boot	
	Size (Bytes)	(words)			Size (Bytes)	No of Pages	Size (Bytes)	No of Pages
ATxmega64A1	64K + 4K	128	Z[7:1]	Z[16:8]	64K	256	4K	16
ATxmega128A1	128K + 8K	256	Z[8:1]	Z[17:9]	128K	256	8K	16
ATxmega192A1	192K + 8K	256	Z[8:1]	Z[18:9]	192K	384	8K	16
ATxmega256A1	256K + 8K	256	Z[8:1]	Z[18:9]	256K	512	8K	16
ATxmega384A1	384K + 8K	256	Z[8:1]	Z[19:9]	384K	768	8K	16

 Table 7-2.
 Number of words and Pages in the Flash.

Table 7-3 on page 15 shows EEPROM memory organization for the XMEGA A1 devices. EEPROM write and erase operations can be performed one page or one byte at a time, while reading the EEPROM is done one byte at a time. For EEPROM access the NVM Address Register (ADDR[m:n]) is used for addressing. The most significant bits in the address (E2PAGE) gives the page number and the least significant address bits (E2BYTE) gives the byte in the page.

Devices	EEPROM	Page Size	E2BYTE	E2PAGE	No of Pages
	Size	(Bytes)			
ATxmega64A1	2 KB	32	ADDR[4:0]	ADDR[10:5]	64
ATxmega128A1	2 KB	32	ADDR[4:0]	ADDR[10:5]	64
ATxmega192A1	2 KB	32	ADDR[4:0]	ADDR[10:5]	64
ATxmega256A1	4 KB	32	ADDR[4:0]	ADDR[11:5]	128
ATxmega384A1	4 KB	32	ADDR[4:0]	ADDR[11:5]	128

Table 7-3.Number of Bytes and Pages in the EEPROM.



8. DMAC - Direct Memory Access Controller

8.1 Features

- Allows High-speed data transfer
 - From memory to peripheral
 - From memory to memory
 - From peripheral to memory
 - From peripheral to peripheral
- 4 Channels
- From 1 byte and up to 16M bytes transfers in a single transaction
- Multiple addressing modes for source and destination address
 - Increment
 - Decrement
 - Static
- 1, 2, 4, or 8 byte Burst Transfers
- Programmable priority between channels

8.2 Overview

The XMEGA A1 has a Direct Memory Access (DMA) Controller to move data between memories and peripherals in the data space. The DMA controller uses the same data bus as the CPU to transfer data.

It has 4 channels that can be configured independently. Each DMA channel can perform data transfers in blocks of configurable size from 1 to 64K bytes. A repeat counter can be used to repeat each block transfer for single transactions up to 16M bytes. Each DMA channel can be configured to access the source and destination memory address with incrementing, decrementing or static addressing. The addressing is independent for source and destination address. When the transaction is complete the original source and destination address can automatically be reloaded to be ready for the next transaction.

The DMAC can access all the peripherals through their I/O memory registers, and the DMA may be used for automatic transfer of data to/from communication modules, as well as automatic data retrieval from ADC conversions, data transfer to DAC conversions, or data transfer to or from port pins. A wide range of transfer triggers is available from the peripherals, Event System and software. Each DMA channel has different transfer triggers.

To allow for continuous transfers, two channels can be interlinked so that the second takes over the transfer when the first is finished and vice versa.

The DMA controller can read from memory mapped EEPROM, but it cannot write to the EEPROM or access the Flash.



9. Event System

9.1 Features

- Inter-peripheral communication and signalling with minimum latency
- CPU and DMA independent operation
- 8 Event Channels allows for up to 8 signals to be routed at the same time
- Events can be generated by
 - Timer/Counters (TCxn)
 - Real Time Counter (RTC)
 - Analog to Digital Converters (ADCx)
 - Analog Comparators (ACx)
 - Ports (PORTx)
 - System Clock (Clk_{SYS})
 - Software (CPU)
- Events can be used by
 - Timer/Counters (TCxn)
 - Analog to Digital Converters (ADCx)
 - Digital to Analog Converters (DACx)
 - Ports (PORTx)
 - DMA Controller (DMAC)
 - IR Communication Module (IRCOM)
- The same event can be used by multiple peripherals for synchronized timing
- Advanced Features
 - Manual Event Generation from software (CPU)
 - Quadrature Decoding
 - Digital Filtering
- Functions in Active and Idle mode

9.2 Overview

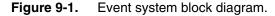
The Event System is a set of features for inter-peripheral communication. It enables the possibility for a change of state in one peripheral to automatically trigger actions in one or more peripherals. These changes in a peripheral that will trigger actions in other peripherals are configurable by software. It is a simple, but powerful system as it allows for autonomous control of peripherals without any use of interrupts, CPU or DMA resources.

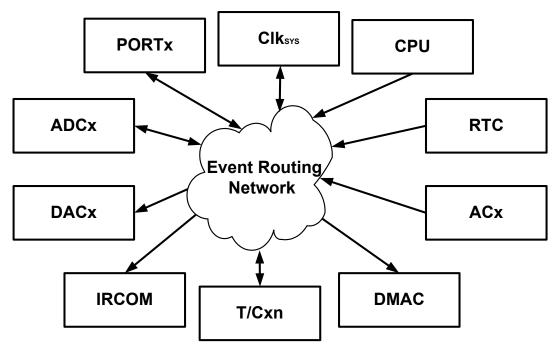
The indication of a change in a peripheral is referred to as an event, and is usually the same as the interrupt conditions for that peripheral. Events are passed between peripherals using a dedicated routing network called the Event Routing Network. Figure 9-1 on page 18 shows a basic block diagram of the Event System with the Event Routing Network and the peripherals to which it is connected. This highly flexible system can be used for simple routing of signals, pin functions or for sequencing of events.

The maximum latency is two CPU clock cycles from when an event is generated in one peripheral, until the actions are triggered in one or more other peripherals.

The Event System is functional in both Active and Idle modes.







The Event Routing Network can directly connect together ADCs, DACs, Analog Comparators (ACx), I/O ports (PORTx), the Real-time Counter (RTC), Timer/Counters (T/C) and the IR Communication Module (IRCOM). Events can also be generated from software (CPU).

All events from all peripherals are always routed into the Event Routing Network. This consist of eight multiplexers where each can be configured in software to select which event to be routed into that event channel. All eight event channels are connected to the peripherals that can use events, and each of these peripherals can be configured to use events from one or more event channels to automatically trigger a software selectable action.



10. System Clock and Clock options

10.1 Features

- Fast start-up time
- Safe run-time clock switching
- Internal Oscillators:
 - 32 MHz run-time calibrated RC oscillator
 - 2 MHz run-time calibrated RC oscillator
 - 32.768 kHz calibrated RC oscillator
 - 32 kHz Ultra Low Power (ULP) oscillator with 1 kHz ouput
- External clock options
 - 0.4 16 MHz Crystal Oscillator
 - 32 kHz Crystal Oscillator
 - External clock
- PLL with internal and external clock options with 1 to 31x multiplication
- Clock Prescalers with 1 to 2048x division
- Fast peripheral clock running at 2 and 4 times the CPU clock speed
- Automatic Run-Time Calibration of internal oscillators
 - Crystal Oscillator failure detection

10.2 Overview

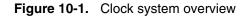
XMEGA A1 has an advanced clock system, supporting a large number of clock sources. It incorporates both integrated oscillators, external crystal oscillators and resonators. A high frequency Phase Locked Loop (PLL) and clock prescalers can be controlled from software to generate a wide range of clock frequencies from the clock source input.

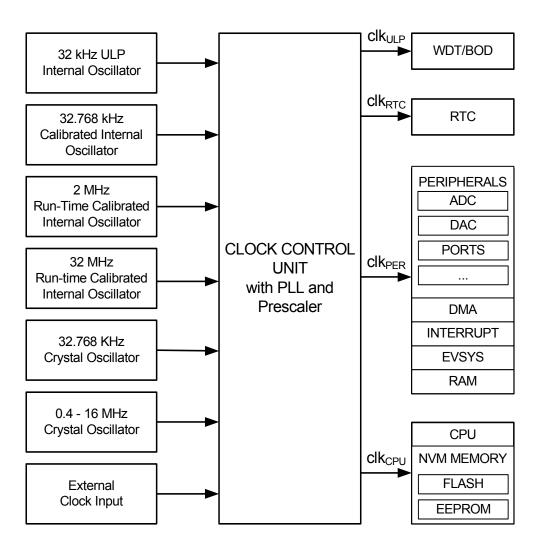
It is possible to switch between clock sources from software during run-time. After reset the device will always start up running from the 2 Mhz internal oscillator.

A calibration feature is available, and can be used for automatic run-time calibration of the internal 2 MHz and 32 MHz oscillators. This reduce frequency drift over voltage and temperature.

A Crystal Oscillator Failure Monitor can be enabled to issue a Non-Maskable Interrupt and switch to internal oscillator if the external oscillator fails. Figure 10-1 on page 20 shows the principal clock system in XMEGA A1.







Each clock source is briefly described in the following sub-sections.

10.3 Clock Options

10.3.1 32 kHz Ultra Low Power Internal Oscillator

The 32 kHz Ultra Low Power (ULP) Internal Oscillator is a very low power consumption clock source. It is used for the Watchdog Timer, Brown-Out Detection and as an asynchronous clock source for the Real Time Counter. This oscillator cannot be used as the system clock source, and it cannot be directly controlled from software.

10.3.2 32.768 kHz Calibrated Internal Oscillator

The 32.768 kHz Calibrated Internal Oscillator is a high accuracy clock source that can be used as the system clock source or as an asynchronous clock source for the Real Time Counter. It is calibrated during production to provide a default frequency which is close to its nominal frequency.



10.3.3 32.768 kHz Crystal Oscillator

The 32.768 kHz Crystal Oscillator is a low power driver for an external watch crystal. It can be used as system clock source or as asynchronous clock source for the Real Time Counter.

10.3.4 0.4 - 16 MHz Crystal Oscillator

The 0.4 - 16 MHz Crystal Oscillator is a driver intended for driving both external resonators and crystals ranging from 400 kHz to 16 MHz.

10.3.5 2 MHz Run-time Calibrated Internal Oscillator

The 2 MHz Run-time Calibrated Internal Oscillator is a high frequency oscillator. It is calibrated during productionn to provide a default frequency which is close to its nominal frequency. The oscillator can use the 32 kHz Calibrated Internal Oscillator or the 32 kHz Crystal Oscillator as a source for calibrating the frequency run-time to compensate for temperature and voltage drift hereby optimizing the accuracy of the oscillator.

10.3.6 32 MHz Run-time Calibrated Internal Oscillator

The 32 MHz Run-time Calibrated Internal Oscillator is a high frequency oscillator. It is calibrated during production to provide a default frequency which is close to its nominal frequency. The oscillator can use the 32 kHz Calibrated Internal Oscillator or the 32 kHz Crystal Oscillator as a source for calibrating the frequency run-time to compensate for temperature and voltage drift hereby optimizing the accuracy of the oscillator.

10.3.7 External Clock input

The external clock input gives the possibility to connect a clock from an external source.

10.3.8 PLL with Multiplication factor 1 - 31x

The PLL provides the possibility of multiplying a frequency by any number from 1 to 31. In combination with the prescalers, this gives a wide range of output frequencies from all clock sources.



11. Power Management and Sleep Modes

11.1 Features

• 5 sleep modes

- Idle
- Power-down
- Power-save
- Standby
- Extended standby
- Power Reduction registers to disable clocks to unused peripherals

11.2 Overview

The XMEGA A1 provides various sleep modes tailored to reduce power consumption to a minimum. All sleep modes are available and can be entered from Active mode. In Active mode the CPU is executing application code. The application code decides when and what sleep mode to enter. Interrupts from enabled peripherals and all enabled reset sources can restore the microcontroller from sleep to Active mode.

In addition, Power Reduction registers provide a method to stop the clock to individual peripherals from software. When this is done, the current state of the peripheral is frozen and there is no power consumption from that peripheral. This reduces the power consumption in Active mode and Idle sleep mode.

11.3 Sleep Modes

11.3.1 Idle Mode

In Idle mode the CPU and Non-Volatile Memory are stopped, but all peripherals including the Interrupt Controller, Event System and DMA Controller are kept running. Interrupt requests from all enabled interrupts will wake the device.

11.3.2 Power-down Mode

In Power-down mode all system clock sources, and the asynchronous Real Time Counter (RTC) clock source, are stopped. This allows operation of asynchronous modules only. The only interrupts that can wake up the MCU are the Two Wire Interface address match interrupts, and asynchronous port interrupts, e.g pin change.

11.3.3 Power-save Mode

Power-save mode is identical to Power-down, with one exception: If the RTC is enabled, it will keep running during sleep and the device can also wake up from RTC interrupts.

11.3.4 Standby Mode

Standby mode is identical to Power-down with the exception that all enabled system clock sources are kept running, while the CPU, Peripheral and RTC clocks are stopped. This reduces the wake-up time when external crystals or resonators are used.

11.3.5 Extended Standby Mode

Extended Standby mode is identical to Power-save mode with the exception that all enabled system clock sources are kept running while the CPU and Peripheral clocks are stopped. This reduces the wake-up time when external crystals or resonators are used.



12. System Control and Reset

12.1 Features

- Multiple reset sources for safe operation and device reset
 - Power-On Reset
 - External Reset
 - Watchdog Reset
 - The Watchdog Timer runs from separate, dedicated oscillator
 - Brown-Out Reset
 - Accurate, programmable Brown-Out levels
 - PDI reset
 - Software reset
- Asynchronous reset
 - No running clock in the device is required for reset
- Reset status register

12.2 Resetting the AVR

During reset, all I/O registers are set to their initial values. The SRAM content is not reset. Application execution starts from the Reset Vector. The instruction placed at the Reset Vector should be an Absolute Jump (JMP) instruction to the reset handling routine. By default the Reset Vector address is the lowest Flash program memory address, '0', but it is possible to move the Reset Vector to the first address in the Boot Section.

The I/O ports of the AVR are immediately tri-stated when a reset source goes active.

The reset functionality is asynchronous, so no running clock is required to reset the device.

After the device is reset, the reset source can be determined by the application by reading the Reset Status Register.

12.3 Reset Sources

12.3.1 Power-On Reset

The MCU is reset when the supply voltage VCC is below the Power-on Reset threshold voltage.

12.3.2 External Reset

The MCU is reset when a low level is present on the RESET pin.

12.3.3 Watchdog Reset

The MCU is reset when the Watchdog Timer period expires and the Watchdog Reset is enabled. The Watchdog Timer runs from a dedicated oscillator independent of the System Clock. For more details see "WDT - Watchdog Timer" on page 24.

12.3.4 Brown-Out Reset

The MCU is reset when the supply voltage VCC is below the Brown-Out Reset threshold voltage and the Brown-out Detector is enabled. The Brown-out threshold voltage is programmable.

12.3.5 PDI reset

The MCU can be reset through the Program and Debug Interface (PDI).



12.3.6 Software reset

The MCU can be reset by the CPU writing to a special I/O register through a timed sequence.

12.4 WDT - Watchdog Timer

12.4.1 Features

- 11 selectable timeout periods, from 8 ms to 8s.
- Two operation modes
 - Standard mode
 - Window mode
- Runs from the 1 kHz output of the 32 kHz Ultra Low Power oscillator
- · Configuration lock to prevent unwanted changes

12.4.2 Overview

The XMEGA A1 has a Watchdog Timer (WDT). The WDT will run continuously when turned on and if the Watchdog Timer is not reset within a software configurable time-out period, the micro-controller will be reset. The Watchdog Reset (WDR) instruction must be run by software to reset the WDT, and prevent microcontroller reset.

The WDT has a Window mode. In this mode the WDR instruction must be run within a specified period called a window. Application software can set the minimum and maximum limits for this window. If the WDR instruction is not executed inside the window limits, the microcontroller will be reset.

A protection mechanism using a timed write sequence is implemented in order to prevent unwanted enabling, disabling or change of WDT settings.

For maximum safety, the WDT also has an Always-on mode. This mode is enabled by programming a fuse. In Always-on mode, application software can not disable the WDT.



13. PMIC - Programmable Multi-level Interrupt Controller

13.1 Features

- Separate interrupt vector for each interrupt
- Short, predictable interrupt response time
- Programmable Multi-level Interrupt Controller
 - 3 programmable interrupt levels
 - Selectable priority scheme within low level interrupts (round-robin or fixed)
 - Non-Maskable Interrupts (NMI)
- · Interrupt vectors can be moved to the start of the Boot Section

13.2 Overview

XMEGA A1 has a Programmable Multi-level Interrupt Controller (PMIC). All peripherals can define three different priority levels for interrupts; high, medium or low. Medium level interrupts may interrupt low level interrupt service routines. High level interrupts may interrupt both lowand medium level interrupt service routines. Low level interrupts have an optional round robin scheme to make sure all interrupts are serviced within a certain amount of time.

The built in oscillator failure detection mechanism can issue a Non-Maskable Interrupt (NMI).

13.3 Interrupt vectors

When an interrupt is serviced, the program counter will jump to the interrupt vector address. The interrupt vector is the sum of the peripheral's base interrupt address and the offset address for specific interrupts in each peripheral. The base addresses for the XMEGA A1 devices are shown in Table 13-1. Offset addresses for each interrupt available in the peripheral are described for each peripheral in the XMEGA A manual. For peripherals or modules that have only one interrupt, the interrupt vector is shown in Table 13-1. The program address is the word address.

Program Address (Base Address)	Source	Interrupt Description
0x000	RESET	
0x002	OSCF_INT_vect	Crystal Oscillator Failure Interrupt vector (NMI)
0x004	PORTC_INT_base	Port C Interrupt base
0x008	PORTR_INT_base	Port R Interrupt base
0x00C	DMA_INT_base	DMA Controller Interrupt base
0x014	RTC_INT_base	Real Time Counter Interrupt base
0x018	TWIC_INT_base	Two-Wire Interface on Port C Interrupt base
0x01C	TCC0_INT_base	Timer/Counter 0 on port C Interrupt base
0x028	TCC1_INT_base	Timer/Counter 1 on port C Interrupt base
0x030	SPIC_INT_vect	SPI on port C Interrupt vector
0x032	USARTC0_INT_base	USART 0 on port C Interrupt base
0x038	USARTC1_INT_base	USART 1 on port C Interrupt base
0x03E	AES_INT_vect	AES Interrupt vector

 Table 13-1.
 Reset and Interrupt Vectors



Table 13-1.	Reset and Interrupt Vectors (Continued)
-------------	---

Program Address (Base Address)	Source	Interrupt Description
0x040	NVM_INT_base	Non-Volatile Memory Interrupt base
0x044	PORTB_INT_base	Port B Interrupt base
0x048	ACB_INT_base	Analog Comparator on Port B Interrupt base
0x04E	ADCB_INT_base	Analog to Digital Converter on Port B Interrupt base
0x056	PORTE_INT_base	Port E Interrupt base
0x05A	TWIE_INT_base	Two-Wire Interface on Port E Interrupt base
0x05E	TCE0_INT_base	Timer/Counter 0 on port E Interrupt base
0x06A	TCE1_INT_base	Timer/Counter 1 on port E Interrupt base
0x072	SPIE_INT_vect	SPI on port E Interrupt vector
0x074	USARTE0_INT_base	USART 0 on port E Interrupt base
0x07A	USARTE1_INT_base	USART 1 on port E Interrupt base
0x080	PORTD_INT_base	Port D Interrupt base
0x084	PORTA_INT_base	Port A Interrupt base
0x088	ACA_INT_base	Analog Comparator on Port A Interrupt base
0x08E	ADCA_INT_base	Analog to Digital Converter on Port A Interrupt base
0x096	TWID_INT_base	Two-Wire Interface on Port D Interrupt base
0x09A	TCD0_INT_base	Timer/Counter 0 on port D Interrupt base
0x0A6	TCD1_INT_base	Timer/Counter 1 on port D Interrupt base
0x0AE	SPID_INT_vector	SPI on port D Interrupt vector
0x0B0	USARTD0_INT_base	USART 0 on port D Interrupt base
0x0B6	USARTD1_INT_base	USART 1 on port D Interrupt base
0x0BC	PORTQ_INT_base	Port Q INT base
0x0C0	PORTH_INT_base	Port H INT base
0x0C4	PORTJ_INT_base	Port J INT base
0x0C8	PORTK_INT_base	Port K INT base
0x0D0	PORTF_INT_base	Port F INT base
0x0D4	TWIF_INT_base	Two-Wire Interface on Port F INT base
0x0D8	TCF0_INT_base	Timer/Counter 0 on port F Interrupt base
0x0E4	TCF1_INT_base	Timer/Counter 1 on port F Interrupt base
0x0EC	SPIF_INT_vector	SPI ion port F Interrupt base
0x0EE	USARTF0_INT_base	USART 0 on port F Interrupt base
0x0F4	USARTF1_INT_base	USART 1 on port F Interrupt base



14. I/O Ports

14.1 Features

- Selectable input and output configuration for each pin individually
- Flexible pin configuration through dedicated Pin Configuration Register
- · Synchronous and/or asynchronous input sensing with port interrupts and events
 - Sense both edges
 - Sense rising edges
 - Sense falling edges
 - Sense low level
- · Asynchronous wake-up from all input sensing configurations
- Two port interrupts with flexible pin masking
- Highly configurable output driver and pull settings:
 - Totem-pole
 - Pull-up/-down
 - Wired-AND
 - Wired-OR
 - Bus-keeper
 - Inverted I/O
- Optional Slew rate control
- Configuration of multiple pins in a single operation
- Read-Modify-Write (RMW) support
- Toggle/clear/set registers for Output and Direction registers
- Clock output on port pin
- Event Channel 0 output on port pin 7
- Mapping of port registers (virtual ports) into bit accessible I/O memory space

14.2 Overview

The XMEGA A1 devices have flexible General Purpose I/O Ports. A port consists of up to 8 pins, ranging from pin 0 to pin 7. The ports implement several functions, including synchronous/asynchronous input sensing, pin change interrupts and configurable output settings. All functions are individual per pin, but several pins may be configured in a single operation.

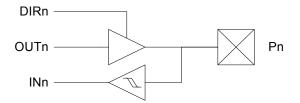
14.3 I/O configuration

All port pins (Pn) have programmable output configuration. In addition, all port pins have an inverted I/O function. For an input, this means inverting the signal between the port pin and the pin register. For an output, this means inverting the output signal between the port register and the port pin. The inverted I/O function can be used also when the pin is used for alternate functions. The port pins also have configurable slew rate limitation to reduce electromagnetic emission.



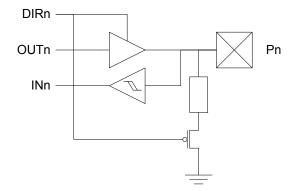
14.3.1 Push-pull



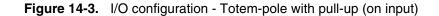


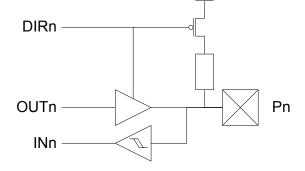
14.3.2 Pull-down





14.3.3 Pull-up

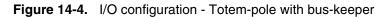


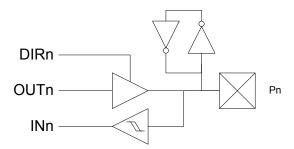


14.3.4 Bus-keeper

The bus-keeper's weak output produces the same logical level as the last output level. It acts as a pull-up if the last level was '1', and pull-down if the last level was '0'.







14.3.5 Others

Figure 14-5. Output configuration - Wired-OR with optional pull-down

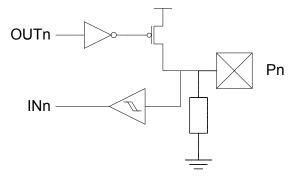
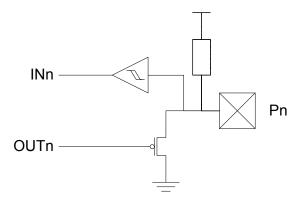


Figure 14-6. I/O configuration - Wired-AND with optional pull-up



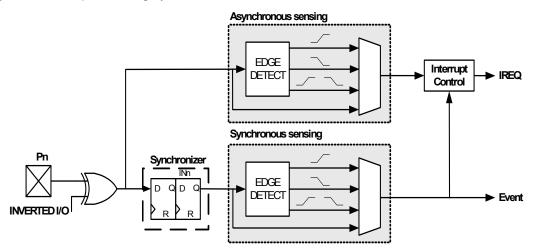


14.4 Input sensing

- Sense both edges
- Sense rising edges
- Sense falling edges
- Sense low level

Input sensing is synchronous or asynchronous depending on the enabled clock for the ports, and the configuration is shown in Figure 14-7 on page 30.

Figure 14-7. Input sensing system overview



When a pin is configured with inverted I/O the pin value is inverted before the input sensing.

14.5 Port Interrupt

Each ports have two interrupts with seperate priority and interrupt vector. All pins on the port can be individually selected as source for each of the interrupts. The interrupts are then triggered according to the input sense configuration for each pin configured as source for the interrupt.

14.6 Alternate Port Functions

In addition to the input/output functions on all port pins, most pins have alternate functions. This means that other modules or peripherals connected to the port can use the port pins for their functions, such as communication or pulse-width modulation. "Pinout and Pin Functions" on page 49 shows which modules on peripherals that enables alternate functions on a pin, and what alternate functions that is available on a pin.



15. T/C - 16-bit Timer/Counter

15.1 Features

- Eight 16-bit Timer/Counters
 - Four Timer/Counters of type 0
 - Four Timer/Counters of type 1
- Four Compare or Capture (CC) Channels in Timer/Counter 0
- Two Compare or Capture (CC) Channels in Timer/Counter 1
- Double Buffered Timer Period Setting
- Double Buffered Compare or Capture Channels
- Waveform Generation:
 - Single Slope Pulse Width Modulation
 - Dual Slope Pulse Width Modulation
 - Frequency Generation
- Input Capture:
 - Input Capture with Noise Cancelling
 - Frequency capture
 - Pulse width capture
 - 32-bit input capture
- Event Counter with Direction Control
- Timer Overflow and Timer Error Interrupts and Events
- One Compare Match or Capture Interrupt and Event per CC Channel
- Supports DMA Operation
- Hi-Resolution Extension (Hi-Res)
- Advanced Waveform Extension (AWEX)

15.2 Overview

XMEGA A1 has eight Timer/Counters, four Timer/Counter 0 and four Timer/Counter 1. The difference between them is that Timer/Counter 0 has four Compare/Capture channels, while Timer/Counter 1 has two Compare/Capture channels.

The Timer/Counters (T/C) are 16-bit and can count any clock, event or external input in the microcontroller. A programmable prescaler is available to get a useful T/C resolution. Updates of Timer and Compare registers are double buffered to ensure glitch free operation. Single slope PWM, dual slope PWM and frequency generation waveforms can be generated using the Compare Channels.

Through the Event System, any input pin or event in the microcontroller can be used to trigger input capture, hence no dedicated pins is required for this. The input capture has a noise canceller to avoid incorrect capture of the T/C, and can be used to do frequency and pulse width measurements.

A wide range of interrupt or event sources are available, including T/C Overflow, Compare match and Capture for each Compare/Capture channel in the T/C.

PORTC, PORTD, PORTE and PORTF each has one Timer/Counter 0 and one Timer/Counter1. Notation of these Timer/Counters are TCC0 (Time/Counter C0), TCC1, TCD0, TCD1, TCE0, TCE1, TCF0, and TCF1, respectively.



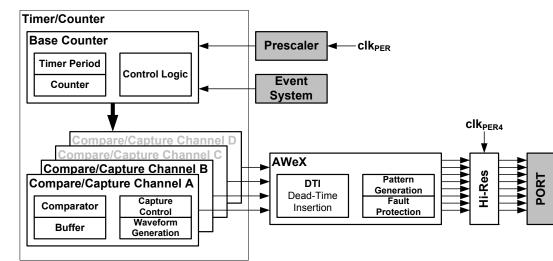


Figure 15-1. Overview of a Timer/Counter and closely related peripherals

The Hi-Resolution Extension can be enabled to increase the waveform generation resolution by 2 bits (4x). This is available for all Timer/Counters. See "Hi-Res - High Resolution Extension" on page 34 for more details.

The Advanced Waveform Extension can be enabled to provide extra and more advanced features for the Timer/Counter. This are only available for Timer/Counter 0. See "AWEX - Advanced Waveform Extension" on page 33 for more details.



16. AWEX - Advanced Waveform Extension

16.1 Features

- Output with complementary output from each Capture channel
- Four Dead Time Insertion (DTI) Units, one for each Capture channel
- 8-bit DTI Resolution
- Separate High and Low Side Dead-Time Setting
- Double Buffered Dead-Time
- Event Controlled Fault Protection
- Single Channel Multiple Output Operation (for BLDC motor control)
- Double Buffered Pattern Generation

16.2 Overview

The Advanced Waveform Extension (AWEX) provides extra features to the Timer/Counter in Waveform Generation (WG) modes. The AWEX enables easy and safe implementation of for example, advanced motor control (AC, BLDC, SR, and Stepper) and power control applications.

Any WG output from a Timer/Counter 0 is split into a complimentary pair of outputs when any AWEX feature is enabled. These output pairs go through a Dead-Time Insertion (DTI) unit that enables generation of the non-inverted Low Side (LS) and inverted High Side (HS) of the WG output with dead time insertion between LS and HS switching. The DTI output will override the normal port value according to the port override setting. Optionally the final output can be inverted by using the invert I/O setting for the port pin.

The Pattern Generation unit can be used to generate a synchronized bit pattern on the port it is connected to. In addition, the waveform generator output from Compare Channel A can be distributed to, and override all port pins. When the Pattern Generator unit is enabled, the DTI unit is bypassed.

The Fault Protection unit is connected to the Event System. This enables any event to trigger a fault condition that will disable the AWEX output. Several event channels can be used to trigger fault on several different conditions.

The AWEX is available for TCC0 and TCE0. The notation of these peripherals are AWEXC and AWEXE.



17. Hi-Res - High Resolution Extension

17.1 Features

- Increases Waveform Generator resolution by 2-bits (4x)
- Supports Frequency, single- and dual-slope PWM operation
- Supports the AWEX when this is enabled and used for the same Timer/Counter

17.2 Overview

The Hi-Resolution (Hi-Res) Extension is able to increase the resolution of the waveform generation output by a factor of 4. When enabled for a Timer/Counter, the Fast Peripheral clock running at four times the CPU clock speed will be as input to the Timer/Counter.

The High Resolution Extension can also be used when an AWEX is enabled and used with a Timer/Counter.

XMEGA A1 devices have four Hi-Res Extensions that each can be enabled for each Timer/Counters pair on PORTC, PORTD, PORTE and PORTF. The notation of these peripherals are HIRESC, HIRESD, HIRESE and HIRESF, respectively.



18. RTC - 16-bit Real-Time Counter

18.1 Features

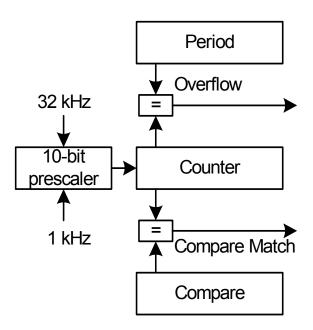
- 16-bit Timer
- Flexible Tick resolution ranging from 1 Hz to 32.768 kHz
- One Compare register
- One Period register
- Clear timer on Overflow or Compare Match
- Overflow or Compare Match event and interrupt generation

18.2 Overview

The XMEGA A1 includes a 16-bit Real-time Counter (RTC). The RTC can be clocked from an accurate 32.768 kHz Crystal Oscillator, the 32.768 kHz Calibrated Internal Oscillator, or from the 32 kHz Ultra Low Power Internal Oscillator. The RTC includes both a Period and a Compare register. For details, see Figure 18-1.

A wide range of Resolution and Time-out periods can be configured using the RTC. With a maximum resolution of $30.5 \ \mu$ s, time-out periods range up to 2000 seconds. With a resolution of 1 second, the maximum time-out period is over 18 hours (65536 seconds).

Figure 18-1. Real Time Counter overview





19. TWI - Two-Wire Interface

19.1 Features

- Four Identical TWI peripherals
- Simple yet Powerful and Flexible Communication Interface
- Both Master and Slave Operation Supported
- Device can Operate as Transmitter or Receiver
- 7-bit Address Space Allows up to 128 Different Slave Addresses
- Multi-master Arbitration Support
- Up to 400 kHz Data Transfer Speed
- Slew-rate Limited Output Drivers
- Noise Suppression Circuitry Rejects Spikes on Bus Lines
- Fully Programmable Slave Address with General Call Support
- Address Recognition Causes Wake-up when in Sleep Mode
- I²C and System Management Bus (SMBus) compatible

19.2 Overview

The Two-Wire Interface (TWI) is a bi-directional wired-AND bus with only two lines, the clock (SCL) line and the data (SDA) line. The protocol makes it possible to interconnect up to 128 individually addressable devices. Since it is a multi-master bus, one or more devices capable of taking control of the bus can be connected.

The only external hardware needed to implement the bus is a single pull-up resistor for each of the TWI bus lines. Mechanisms for resolving bus contention are inherent in the TWI protocol.

PORTC, PORTD, PORTE, and PORTF each has one TWI. Notation of these peripherals are TWIC, TWID, TWIE, and TWIF, respectively.



20. SPI - Serial Peripheral Interface

20.1 Features

- Four Identical SPI peripherals
- Full-duplex, Three-wire Synchronous Data Transfer
- Master or Slave Operation
- LSB First or MSB First Data Transfer
- Seven Programmable Bit Rates
- End of Transmission Interrupt Flag
- Write Collision Flag Protection
- Wake-up from Idle Mode
- Double Speed (CK/2) Master SPI Mode

20.2 Overview

The Serial Peripheral Interface (SPI) allows high-speed full-duplex, synchronous data transfer between different devices. Devices can communicate using a master-slave scheme, and data is transferred both to and from the devices simultaneously.

PORTC, PORTD, PORTE, and PORTF each has one SPI. Notation of these peripherals are SPIC, SPID, SPIE, and SPIF, respectively.



21. USART

21.1 Features

- Eight Identical USART peripherals
- Full Duplex Operation (Independent Serial Receive and Transmit Registers)
- Asynchronous or Synchronous Operation
- Master or Slave Clocked Synchronous Operation
- High-resolution Arithmetic Baud Rate Generator
- Supports Serial Frames with 5, 6, 7, 8, or 9 Data Bits and 1 or 2 Stop Bits
- Odd or Even Parity Generation and Parity Check Supported by Hardware
- Data OverRun Detection
- Framing Error Detection
- Noise Filtering Includes False Start Bit Detection and Digital Low Pass Filter
- Three Separate Interrupts on TX Complete, TX Data Register Empty and RX Complete
- Multi-processor Communication Mode
- Double Speed Asynchronous Communication Mode
- Master SPI mode for SPI communication
- IrDA support through the IRCOM module

21.2 Overview

The Universal Synchronous and Asynchronous serial Receiver and Transmitter (USART) is a highly flexible serial communication module. The USART supports full duplex communication, and both asynchronous and clocked synchronous operation. The USART can also be set in Master SPI mode to be used for SPI communication.

Communication is frame based, and the frame format can be customized to support a wide range of standards. The USART is buffered in both direction, enabling continued data transmission without any delay between frames. There are separate interrupt vectors for receive and transmit complete, enabling fully interrupt driven communication. Frame error and buffer overflow are detected in hardware and indicated with separate status flags. Even or odd parity generation and parity check can also be enabled.

One USART can use the IRCOM module to support IrDA 1.4 physical compliant pulse modulation and demodulation for baud rates up to 115.2 kbps.

PORTC, PORTD, PORTE, and PORTF each has two USARTs. Notation of these peripherals are USARTC0, USARTC1, USARTD0, USARTD1, USARTE0, USARTE1, USARTF0, USARTF1, respectively.



22. IRCOM - IR Communication Module

22.1 Features

- Pulse modulation/demodulation for infrared communication
- Compatible to IrDA 1.4 physical for baud rates up to 115.2 kbps
- Selectable pulse modulation scheme
 - 3/16 of baud rate period
 - Fixed pulse period, 8-bit programmable
 - Pulse modulation disabled
- Built in filtering
- · Can be connected to and used by one USART at a time

22.2 Overview

XMEGA contains an Infrared Communication Module (IRCOM) for IrDA communication with baud rates up to 115.2 kbps. This supports three modulation schemes: 3/16 of baud rate period, fixed programmable pulse time based on the Peripheral Clock speed, or pulse modulation disabled. There is one IRCOM available which can be connected to any USART to enable infrared pulse coding/decoding for that USART.



23. Crypto Engine

23.1 Features

- Data Encryption Standard (DES) CPU instruction
- Advanced Encryption Standard (AES) Crypto module
- DES Instruction
 - Encryption and Decryption
 - Single-cycle DES instruction
 - Encryption/Decryption in 16 clock cycles per 8-byte block
- AES Crypto Module
 - Encryption and Decryption
 - Support 128-bit keys
 - Support XOR data load mode to the State memory for Cipher Block Chaining
 - Encryption/Decryption in 375 clock cycles per 16-byte block

23.2 Overview

The Advanced Encryption Standard (AES) and Data Encryption Standard (DES) are two commonly used encryption standards. These are supported through an AES peripheral module and a DES CPU instruction. All communication interfaces and the CPU can optionally use AES and DES encrypted communication and data storage.

DES is supported by a DES instruction in the AVR XMEGA CPU. The 8-byte key and 8-byte data blocks must be loaded into the Register file, and then DES must be executed 16 times to encrypt/decrypt the data block.

The AES Crypto Module encrypts and decrypts 128-bit data blocks with the use of a 128-bit key. The key and data must be loaded into the key and state memory in the module before encryption/decryption is started. It takes 375 peripheral clock cycles before the encryption/decryption is done and decrypted/encrypted data can be read out, and an optional interrupt can be generated. The AES Crypto Module also has DMA support with transfer triggers when encryption/decryption is done and optional auto-start of encryption/decryption when the state memory is fully loaded.



24. ADC - 12-bit Analog to Digital Converter

24.1 Features

- Two ADCs with 12-bit resolution
- 2 Msps sample rate for each ADC
- Signed and Unsigned conversions
- 4 result registers with individual input channel control for each ADC
- 8 single ended inputs for each ADC
- 8x4 differential inputs for each ADC
- 4 internal inputs:
 - Integrated Temperature Sensor
 - DAC Output
 - VCC voltage divided by 10
 - Bandgap voltage
- Software selectable gain of 2, 4, 8, 16, 32 or 64
- Software selectable resolution of 8- or 12-bit.
- Internal or External Reference selection
- Event triggered conversion for accurate timing
- DMA transfer of conversion results
- Interrupt/Event on compare result

24.2 Overview

XMEGA A1 devices have two Analog to Digital Converters (ADC), see Figure 24-1 on page 42. The two ADC modules can be operated simultaneously, individually or synchronized.

The ADC converts analog voltages to digital values. The ADC has 12-bit resolution and is capable of converting up to 2 million samples per second. The input selection is flexible, and both single-ended and differential measurements can be done. For differential measurements an optional gain stage is available to increase the dynamic range. In addition several internal signal inputs are available. The ADC can provide both signed and unsigned results.

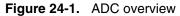
This is a pipeline ADC. A pipeline ADC consists of several consecutive stages, where each stage convert one part of the result. The pipeline design enables high sample rate at low clock speeds, and remove limitations on samples speed versus propagation delay. This also means that a new analog voltage can be sampled and a new ADC measurement started while other ADC measurements are ongoing.

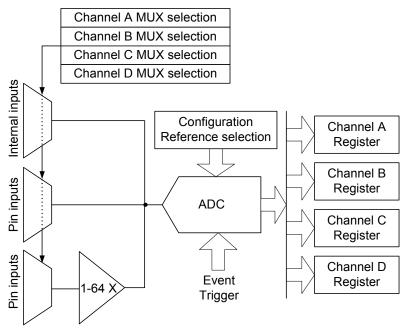
ADC measurements can either be started by application software or an incoming event from another peripheral in the device. Four different result registers with individual input selection (MUX selection) are provided to make it easier for the application to keep track of the data. Each result register and MUX selection pair is referred to as an ADC Channel. It is possible to use DMA to move ADC results directly to memory or peripherals when conversions are done.

Both internal and external analog reference voltages can be used. An accurate internal 1.0V reference is available.

An integrated temperature sensor is available and the output from this can be measured with the ADC. The output from the DAC, VCC/10 and the Bandgap voltage can also be measured by the ADC.







Each ADC has four MUX selection registers with a corresponding result register. This means that four channels can be sampled within 1.5 μ s without any intervention by the application other than starting the conversion. The results will be available in the result registers.

The ADC may be configured for 8- or 12-bit result, reducing the minimum conversion time (propagation delay) from 3.5 µs for 12-bit to 2.5 µs for 8-bit result.

ADC conversion results are provided left- or right adjusted with optional '1' or '0' padding. This eases calculation when the result is represented as a signed integer (signed 16-bit number).

PORTA and PORTB each has one ADC. Notation of these peripherals are ADCA and ADCB, respectively.

25. DAC - 12-bit Digital to Analog Converter

25.1 Features

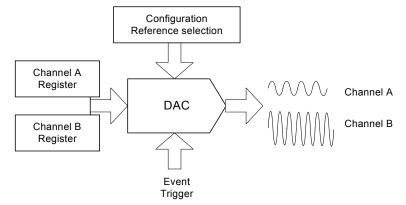
- Two DACs with 12-bit resolution
- Up to 1 Msps conversion rate for each DAC
- Flexible conversion range
- Multiple trigger sources
- 1 continuous output or 2 Sample and Hold (S/H) outputs for each DAC
- Built-in offset and gain calibration
- High drive capabilities
- Low Power Mode

25.2 Overview

The XMEGA A1 devices features two 12-bit, 1 Msps DACs with built-in offset and gain calibration, see Figure 25-1 on page 43.

A DAC converts a digital value into an analog signal. The DAC may use an internal 1.0 voltage as the upper limit for conversion, but it is also possible to use the supply voltage or any applied voltage in-between. The external reference input is shared with the ADC reference input.

Figure 25-1. DAC overview



Each DAC has one continuous output with high drive capabilities for both resistive and capacitive loads. It is also possible to split the continuous time channel into two Sample and Hold (S/H) channels, each with separate data conversion registers.

A DAC conversion may be started from the application software by writing the data conversion registers. The DAC can also be configured to do conversions triggered by the Event System to have regular timing, independent of the application software. DMA may be used for transferring data from memory locations to DAC data registers.

The DAC has a built-in calibration system to reduce offset and gain error when loading with a calibration value from software.

PORTA and PORTB each has one DAC. Notation of these peripherals are DACA and DACB. respectively.



26. AC - Analog Comparator

26.1 Features

- Four Analog Comparators
- Selectable Power vs. Speed
- Selectable hysteresis
 - 0, 20 mV, 50 mV
- Analog Comparator output available on pin
- Flexible Input Selection
 - All pins on the port
 - Output from the DAC
 - Bandgap reference voltage.
 - Voltage scaler that can perform a 64-level scaling of the internal VCC voltage.
- Interrupt and event generation on
 - Rising edge
 - Falling edge
 - Toggle
- Window function interrupt and event generation on
 - Signal above window
 - Signal inside window
 - Signal below window

26.2 Overview

XMEGA A1 features four Analog Comparators (AC). An Analog Comparator compares two voltages, and the output indicates which input is largest. The Analog Comparator may be configured to give interrupt requests and/or events upon several different combinations of input change.

Both hysteresis and propagation delays may be adjusted in order to find the optimal operation for each application.

A wide range of input selection is available, both external pins and several internal signals can be used.

The Analog Comparators are always grouped in pairs (AC0 and AC1) on each analog port. They have identical behavior but separate control registers.

Optionally, the state of the comparator is directly available on a pin.

PORTA and PORTB each has one AC pair. Notations are ACA and ACB, respectively.



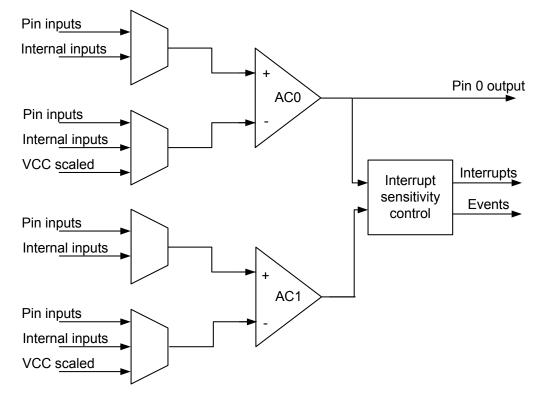


Figure 26-1. Analog comparator overview



26.3 Input Selection

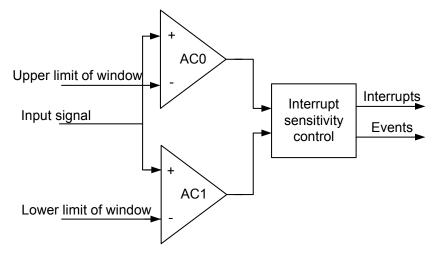
The Analog comparators have a very flexible input selection and the two comparators grouped in a pair may be used to realize a window function. One pair of analog comparators is shown in Figure 26-1 on page 45.

- Input selection from pin
 - Pin 0, 1, 2, 3, 4, 5, 6 selectable to positive input of analog comparator
 - Pin 0, 1, 3, 5, 7 selectable to negative input of analog comparator
- Internal signals available on positive analog comparator inputs
 Output from 12-bit DAC
- Internal signals available on negative analog comparator inputs
 - 64-level scaler of the VCC, available on negative analog comparator input
 - Bandgap voltage reference
 - Output from 12-bit DAC

26.4 Window Function

The window function is realized by connecting the external inputs of the two analog comparators in a pair as shown in Figure 26-2.







27. OCD - On-chip Debug

27.1 Features

- Complete Program Flow Control
 - Go, Stop, Reset, Step into, Step over, Step out, Run-to-Cursor
- Debugging on C and high-level language source code level
- Debugging on Assembler and disassembler level
- 1 dedicated program address or source level breakpoint for AVR Studio / debugger
- 4 Hardware Breakpoints
- Unlimited Number of User Program Breakpoints
- Unlimited Number of User Data Breakpoints, with break on:
 - Data location read, write or both read and write
 - Data location content equal or not equal to a value
 - Data location content is greater or less than a value
 - Data location content is within or outside a range
 - Bits of a data location are equal or not equal to a value
- Non-Intrusive Operation
 - No hardware or software resources in the device are used
- High Speed Operation
 - No limitation on debug/programming clock frequency versus system clock frequency

27.2 Overview

The XMEGA A1 has a powerful On-Chip Debug (OCD) system that - in combination with Atmel's development tools - provides all the necessary functions to debug an application. It has support for program and data breakpoints, and can debug an application from C and high level language source code level, as well as assembler and disassembler level. It has full Non-Intrusive Operation and no hardware or software resources in the device are used. The ODC system is accessed through an external debugging tool which connects to the JTAG or PDI physical interfaces. Refer to "PDI - Program and Debug Interface" on page 48.



28. PDI - Program and Debug Interface

28.1 Features

- PDI Program and Debug Interface (Atmel proprietary 2-pin interface)
- JTAG Interface (IEEE std. 1149.1 compliant)
- Boundary-scan capabilities according to the IEEE Std. 1149.1 (JTAG)
- Access to the OCD system
- Programming of Flash, EEPROM, Fuses and Lock Bits

28.2 Overview

The programming and debug facilities are accessed through the JTAG and PDI physical interfaces. The PDI physical interface uses one dedicated pin together with the Reset pin, and no general purpose pins are used. JTAG uses four general purpose pins on PORTB.

The PDI is an Atmel proprietary protocol for communication between the microcontroller and Atmel's or third party development tools.

28.3 IEEE 1149.1 (JTAG) Boundary-scan

The JTAG physical layer handles the basic low-level serial communication over four I/O lines named TMS, TCK, TDI, and TDO. It complies to the IEEE Std. 1149.1 for test access port and boundary scan.

28.3.1 Boundary-scan Order

Table 29-12 on page 55 shows the Scan order between TDI and TDO when the Boundary-scan chain is selected as data path. Bit 0 is the LSB; the first bit scanned in, and the first bit scanned out. The scan order follows the pin-out order. Bit 4, 5, 6 and 7 of Port B is not in the scan chain, since these pins constitute the TAP pins when the JTAG is enabled.

28.3.2 Boundary-scan Description Language Files

Boundary-scan Description Language (BSDL) files describe Boundary-scan capable devices in a standard format used by automated test-generation software. The order and function of bits in the Boundary-scan Data Register are included in this description. BSDL files are available for ATxmega384/256/192/128/64A1 devices.

See Table 29-12 on page 55 for ATxmega384/256/192/128/64A1 Boundary Scan Order.



29. Pinout and Pin Functions

The pinout of XMEGA A1 is shown in "Pinout/Block Diagram" on page 3. In addition to general I/O functionality, each pin may have several functions. This will depend on which peripheral is enabled and connected to the actual pin. Only one of the alternate pin functions can be used at time.

29.1 Alternate Pin Function Description

The tables below shows the notation for all pin functions available and describes its function.

29.1.1 Operation/Power Supply

VCC	Digital supply voltage
AVCC	Analog supply voltage
GND	Ground

29.1.2 Port Interrupt functions

SYNC	Port pin with full synchronous and limited asynchronous interrupt function
ASYNC	Port pin with full synchronous and full asynchronous interrupt function

29.1.3 Analog functions

ACn	Analog Comparator input pin n
AC0OUT	Analog Comparator 0 Output
ADCn	Analog to Digital Converter input pin n
DACn	Digital to Analog Converter output pin n
AREF	Analog Reference input pin

29.1.4 EBI functions

An	Address line n	
Dn	Data line n	
CSn	Chip Select n	
ALEn	Address Latch Enable pin n	(SRAM)
RE	Read Enable	(SRAM)
WE	External Data Memory Write	(SRAM /SDRAM)
BAn	Bank Address	(SDRAM)
CAS	Column Access Strobe	(SDRAM)
CKE	SDRAM Clock Enable	(SDRAM)
CLK	SDRAM Clock	(SDRAM)
DQM	Data Mask Signal/Output Enable	(SDRAM)



RAS	Row Access Strobe	(SDRAM)
2P	2 Port Interface	
ЗP	3 Port Interface	

29.1.5 Timer/Counter and AWEX functions

OCnx	Output Compare Channel x for Timer/Counter n
OCnx	Inverted Output Compare Channel x for Timer/Counter n
OCnxLS	Output Compare Channel x Low Side for Timer/Counter n
OCnxHS	Output Compare Channel x High Side for Timer/Counter n

29.1.6 Communication functions

SCL	Serial Clock for TWI
SDA	Serial Data for TWI
SCLIN	Serial Clock In for TWI when external driver interface is enabled
SCLOUT	Serial Clock Out for TWI when external driver interface is enabled
SDAIN	Serial Data In for TWI when external driver interface is enabled
SDAOUT	Serial Data Out for TWI when external driver interface is enabled
XCKn	Transfer Clock for USART n
RXDn	Receiver Data for USART n
TXDn	Transmitter Data for USART n
<u>SS</u>	Slave Select for SPI
MOSI	Master Out Slave In for SPI
MISO	Master In Slave Out for SPI
SCK	Serial Clock for SPI

29.1.7 Oscillators, Clock and Event

TOSCn	Timer Oscillator pin n
XTALn	Input/Output for inverting Oscillator pin n
CLKOUT	Peripheral Clock Output
EVOUT	Event Channel 0 Output

29.1.8 Debug/System functions

RESET	Reset pin
PDI_CLK	Program and Debug Interface Clock pin
PDI_DATA	Program and Debug Interface Data pin
тск	JTAG Test Clock



8067M-AVR-09/10

TDI	JTAG Test Data In
TDO	JTAG Test Data Out
TMS	JTAG Test Mode Select

29.2 Alternate Pin Functions

The tables below show the primary/default function for each pin on a port in the first column, the pin number in the second column, and then all alternate pin functions in the remaining columns. The head row shows what peripheral that enable and use the alternate pin functions.

Table 29-1. Port A - Alternate functions

PORT A	PIN #	INTERRUPT	ADCA POS	ADCA NEG	ADCA GAINPOS	ADCA GAINNEG	ACA POS	ACA NEG	ACA OUT	DACA	REFA
GND	93										
AVCC	94										
PA0	95	SYNC	ADC0	ADC0	ADC0		AC0	AC0			AREF
PA1	96	SYNC	ADC1	ADC1	ADC1		AC1	AC1			
PA2	97	SYNC/ASYNC	ADC2	ADC2	ADC2		AC2			DAC0	
PA3	98	SYNC	ADC3	ADC3	ADC3		AC3	AC3		DAC1	
PA4	99	SYNC	ADC4		ADC4	ADC4	AC4				
PA5	100	SYNC	ADC5		ADC5	ADC5	AC5	AC5			
PA6	1	SYNC	ADC6		ADC6	ADC6	AC6				
PA7	2	SYNC	ADC7		ADC7	ADC7		AC7	AC0OUT		

Table 29-2. Port B - Alternate functions

PORT B	PIN #	INTERRUPT	ADCB POS	ADCB NEG	ADCB GAINPOS	ADCB GAINNEG	ACB POS	ACB NEG	ACB OUT	DACB	REFB	JTAG
GND	3											
AVCC	4											
PB0	5	SYNC	ADC0	ADC0	ADC0		AC0	AC0			AREF	
PB1	6	SYNC	ADC1	ADC1	ADC1		AC1	AC1				
PB2	7	SYNC/ASYNC	ADC2	ADC2	ADC2		AC2			DAC0		
PB3	8	SYNC	ADC3	ADC3	ADC3		AC3	AC3		DAC1		
PB4	9	SYNC	ADC4		ADC4	ADC4	AC4					TMS
PB5	10	SYNC	ADC5		ADC5	ADC5	AC5	AC5				TDI
PB6	11	SYNC	ADC6		ADC6	ADC6	AC6					тск
PB7	12	SYNC	ADC7		ADC7	ADC7		AC7	AC0OUT			TDO



PORT C	PIN #	INTERRUPT	TCC0	AWEXC	TCC1	USARTC0	USARTC1	SPIC	TWIC	CLOCKOUT	EVENTOUT
GND	13										
vcc	14										
PC0	15	SYNC	OC0A	OC0ALS					SDA		
PC1	16	SYNC	OC0B	OC0AHS		XCK0			SCL		
PC2	17	SYNC/ASYNC	OCOC	OC0BLS		RXD0					
PC3	18	SYNC	OC0D	OC0BHS		TXD0					
PC4	19	SYNC		OC0CLS	OC1A			SS			
PC5	20	SYNC		OC0CHS	OC1B		XCK1	MOSI			
PC6	21	SYNC		OC0DLS			RXD1	MISO			
PC7	22	SYNC		OC0DHS			TXD1	SCK		CLKOUT	EVOUT

Table 29-4. Port D - Alternate functions

PORT D	PIN #	INTERRUPT	TCD0	TCD1	USARTD0	USARTD1	SPID	TWID	CLOCKOUT	EVENTOUT
GND	23									
vcc	24									
PD0	25	SYNC	OC0A					SDA		
PD1	26	SYNC	OC0B		ХСК0			SCL		
PD2	27	SYNC/ASYNC	OC0C		RXD0					
PD3	28	SYNC	OC0D		TXD0					
PD4	29	SYNC		OC1A			SS			
PD5	30	SYNC		OC1B		XCK1	MOSI			
PD6	31	SYNC				RXD1	MISO			
PD7	32	SYNC				TXD1	SCK		CLKOUT	EVOUT

Table 29-5. Port E - Alternate functions

PORT E	PIN #	INTERRUPT	TCE0	AWEXE	TCE1	USARTE0	USARTE1	SPIE	TWIE	CLOCKOUT	EVENTOUT
GND	33										
vcc	34										
PE0	35	SYNC	OC0A	OC0ALS					SDA		
PE1	36	SYNC	OC0B	OC0AHS		ХСК0			SCL		
PE2	37	SYNC/ASYNC	OC0C	OC0BLS		RXD0					
PE3	38	SYNC	OC0D	OC0BHS		TXD0					
PE4	39	SYNC		OC0CLS	OC1A			SS			
PE5	40	SYNC		OC0CHS	OC1B		XCK1	MOSI			
PE6	41	SYNC		OC0DLS			RXD1	MISO			
PE7	42	SYNC		OC0DHS			TXD1	SCK		CLKOUT	EVOUT



Table 29-6. Port F - Alternate functions

PORT F	PIN #	INTERRUPT	TCF0	TCF1	USARTF0	USARTF1	SPIF	TWIF
GND	43							
VCC	44							
PF0	45	SYNC	OC0A					SDA
PF1	46	SYNC	OC0B		XCK0			SCL
PF2	47	SYNC/ASYNC	OC0C		RXD0			
PF3	48	SYNC	OC0D		TXD0			
PF4	49	SYNC		OC1A			SS	
PF5	50	SYNC		OC1B		XCK1	MOSI	
PF6	51	SYNC				RXD1	MISO	
PF7	52	SYNC				TXD1	SCK	

Table 29-7. Port H - Alternate functions

PORT H	PIN #	INTERRUPT	SDRAM 3P	SRAM ALE1 3P	SRAM ALE12 3P	LPC ALE1 3P	LPC ALE1 2P	LPC ALE12 2P
GND	53							
vcc	54							
PH0	55	SYNC	WE	WE	WE	WE	WE	WE
PH1	56	SYNC	CAS	RE	RE	RE	RE	RE
PH2	57	SYNC/ASYNC	RAS	ALE1	ALE1	ALE1	ALE1	ALE1
PH3	58	SYNC	DQM		ALE2			ALE2
PH4	59	SYNC	BA0	CS0/A16	CS0	CS0/A16	CS0	CS0/A16
PH5	60	SYNC	BA1	CS1/A17	CS1	CS1/A17	CS1	CS1/A17
PH6	61	SYNC	CKE	CS2/A18	CS2	CS2/A18	CS2	CS2/A18
PH7	62	SYNC	CLK	CS3/A19	CS3	CS3/A19	CS3	CS3/A19

Table 29-8. Port J - Alternate functions

PORT J	PIN #	INTERRUPT	SDRAM 3P	SRAM ALE1 3P	SRAM ALE12 3P	LPC ALE1 3P	LPC ALE1 2P	LPC ALE12 2P
GND	63							
vcc	64							
PJ0	65	SYNC	D0	D0	D0	D0/A0	D0/A0	D0/A0/A8
PJ1	66	SYNC	D1	D1	D1	D1/A1	D1/A1	D1/A1/A9
PJ2	67	SYNC/ASYNC	D2	D2	D2	D2/A2	D2/A2	D2/A2/A10
PJ3	68	SYNC	D3	D3	D3	D3/A3	D3/A3	D3/A3/A11
PJ4	69	SYNC	A8	D4	D4	D4/A4	D4/A4	D4/A4/A12
PJ5	70	SYNC	A9	D5	D5	D5/A5	D5/A5	D5/A5/A13
PJ6	71	SYNC	A10	D6	D6	D6/A6	D6/A6	D6/A6/A14
PJ7	72	SYNC	A11	D7	D7	D7/A7	D7/A7	D7/A7/A15



LPC ALE12 2P

PORT K PIN # INTERRUPT SDRAM 3P SRAM ALE1 3P SRAM ALE12 3P LPC ALE1 3P LPC ALE1 2P GND 73 vcc 74 PK0 75 SYNC A0 A0/A8 A0/A8/A16 A8 SYNC A1/A9/A17 PK1 A1/A9 A9 76 A1 PK2 77 SYNC/ASYNC A2 A2/A10 A2/A10/A18 A10 РК3 78 SYNC А3 A3/A11 A3/A11/A19 A11 SYNC PK4 A4/A12 A4/A12/A20 79 A4 A12 PK5 80 SYNC A5 A5/A13 A5/A13/A21 A13 PK6 81 SYNC A6 A6/A14 A6/A14/A22 A14 SYNC A7/A15 A7/A15/A23 PK7 82 A7 A15

Table 29-9. Port K - Alternate functions

Table 29-10. Port Q - Alternate functions

PORT Q	PIN #	INTERRUPT	TOSC
vcc	83		
GND	84		
PQ0	85	SYNC	TOSC1
PQ1	86	SYNC	TOSC2
PQ2	87	SYNC/ASYNC	
PQ3	88	SYNC	

Table 29-11. Port R- Alternate functions

PORT R	PIN #	INTERRUPT	PDI	XTAL
PDI	89		PDI_DATA	
RESET	90		PDI_CLOCK	
PRO	91	SYNC		XTAL2
PR1	92	SYNC		XTAL1



Bit Number	Signal Name	Module
149	PQ3.Bidir	
148	PQ3.Control]
147	PQ2.Bidir	
146	PQ2.Control	
145	PQ1.Bidir	PORT Q
144	PQ1.Control	
143	PQ0.Bidir	
142	PQ0.Control	
141	PK7.Bidir	
140	PK7.Control	
139	PK6.Bidir	
138	PK6.Control	
137	PK5.Bidir	
136	PK5.Control	
135	PK4.Bidir	
134	PK4.Control	
133	PK3.Bidir	PORT K
132	PK3.Control]
131	PK2.Bidir	
130	PK2.Control	
129	PK1.Bidir	
128	PK1.Control	
127	PK0.Bidir	
126	PK0.Control	
125	PJ7.Bidir	
124	PJ7.Control	
123	PJ6.Bidir	
122	PJ6.Control	
121	PJ5.Bidir	
120	PJ5.Control	
119	PJ4.Bidir	
118	PJ4.Control	
117	PJ3.Bidir	PORT J
116	PJ3.Control	
115	PJ2.Bidir	
114	PJ2.Control	
113	PJ1.Bidir	
112	PJ1.Control	1
111	PJ0.Bidir	1
110	PJ0.Control	1
109	PH7.Bidir	
108	PH7.Control	1
107	PH6.Bidir	1
106	PH6.Control	1
105	PH5.Bidir	1
104	PH5.Control	1
103	PH4.Bidir	1
102	PH4.Control	1
101	PH3.Bidir	PORT H
100	PH3.Control	1
99	PH2.Bidir	1
98	PH2.Control	1
97	PH1.Bidir	1
96	PH1.Control	1
95	PH1.Control PH0.Bidir	1
94	PH0.Bidir PH0.Control	4

Table 29-12.	ATxmega384/256/192/128/64A1	Boundary Scan Order
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Bit Number	Signal Name	Module
93	PF7.Bidir	
92	PF7.Control	
91	PF6.Bidir	
90	PF6.Control	
89	PF5.Bidir	
88	PF5.Control	
87	PF4.Bidir	
86	PF4.Control	PORT F
85	PF3.Bidir	
84	PF3.Control	-
83	PF2.Bidir	-
82	PF2.Control	-
81	PF1.Bidir	-
80	PF1.Control	-
79 78	PF0.Bidir PF0.Control	•
77	PE7.Bidir	
76	PE7.Control	
75	PE6.Bidir	
74	PE6.Control	-
73	PE5.Bidir	1
72	PE5.Control	1
71	PE4.Bidir	1
70	PE4.Control	
69	PE3.Bidir	PORT E
68	PE3.Control	
67	PE2.Bidir	
66	PE2.Control	
65	PE1.Bidir	
64	PE1.Control	
63	PE0.Bidir	
62	PE0.Control	
61	PD7.Bidir	
60	PD7.Control	
59	PD6.Bidir	
58	PD6.Control	
57	PD5.Bidir	
56	PD5.Control	-
55	PD4.Bidir	-
54	PD4.Control	PORT D
53	PD3.Bidir	
52	PD3.Control PD2.Bidir	4
51 50	PD2.Bidir PD2.Control	4
49	PD2.Control PD1 Bidir	1
49	PD1.Control	1
47	PD0.Bidir	1
46	PD0.Control	1
45	PC7.Bidir	1
44	PC7.Control	1
43	PC6.Bidir	1
42	PC6.Control	1
41	PC5.Bidir]
40	PC5.Control	
39	PC4.Bidir	
38	PC4.Control	DODT O
37	PC3.Bidir	PORT C
36	PC3.Control	
35	PC2.Bidir	
34	PC2.Control	1
33	PC1.Bidir	1
32	PC1.Control	4
31	PC0.Bidir	4
30	PC0.Control	



Bit Number	Signal Name	Module
29	PB3.Bidir	
28	PB3.Control	
27	PB2.Bidir	
26	PB2.Control	BOBTE
25	PB1.Bidir	PORT B
24	PB1.Control	
23	PB0.Bidir	
22	PB0.Control	
21	PA7.Bidir	
20	PA7.Control	
19	PA6.Bidir	
18	PA6.Control	
17	PA5.Bidir	
16	PA5.Control	
15	PA4.Bidir	
14	PA4.Control	POBT A
13	PA3.Bidir	PORTA
12	PA3.Control	
11	PA2.Bidir	
10	PA2.Control	
9	PA1.Bidir	
8	PA1.Control	
7	PA0.Bidir	
6	PA0.Control	
5	PR1.Bidir	
4	PR1.Control	POBT B
3	PR0.Bidir	PORTR
2	PR0.Control	
1	RESET.Observe_Only	RESET
0	PDI_DATA.Observe_Only	PDI Data



30. Peripheral Module Address Map

The address maps show the base address for each peripheral and module in XMEGA A1. For complete register description and summary for each peripheral module, refer to the XMEGA A Manual.

Base Address Name Description 0x0000 GPIO General Purpose IO Registers 0x0011 VPORT0 Virtual Port 0 0x0012 VPORT2 Virtual Port 1 0x0013 VPORT2 Virtual Port 2 0x0010 VPORT2 Virtual Port 2 0x0010 VPORT2 Virtual Port 2 0x0010 CPU CPU 0x0010 CLK Clock Control 0x0060 DFLLRC2M DFLL for the 32 MHz Internal RC Oscillator 0x0070 PR Power Reduction 0x0080 MCU MCU Control 0x0080 MCU MCU Control 0x0080 MCU MCU Control 0x0080 MCU MCU Control 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0100 DMA DMA Controller 0x0200 ADCA Analog to Digital Converter on port A 0x0200			
bx0010 VPORT0 Virtual Port 1 0x0014 VPORT1 Virtual Port 1 0x0016 VPORT3 Virtual Port 2 0x0010 VPORT3 Virtual Port 3 0x0010 VPORT3 Virtual Port 3 0x0010 CPU CPU 0x0040 CLK Clock Control 0x0050 OSC Oscillator Control 0x0060 DFLLRC2M DFLL for the 2 MHz Internal RC Oscillator 0x0070 PR Power Reduction 0x0070 PMIC Programmable Multilevel Interrupt Controller 0x0080 WDC1 MCU Oscillato 0x0100 DMA DMA Controller Oscillato	Base Address	Name	Description
0x0014 VPORT1 Virtual Port 1 0x0016 VPORT2 Virtual Port 3 0x0030 CPU CPU 0x0040 CLK Clock Control 0x0040 CLK Clock Control 0x0040 GLK Clock Control 0x0050 OSC Oscillator Control 0x0060 DFLLRC32M DFLL for the 32 MHz Internal RC Oscillator 0x0060 DFLRC2M DFLL for the 32 MHz RC Oscillator 0x0070 PR Power Reduction 0x0080 WDT Watch-Dog Timer 0x0080 MCU Programmable Multilevel Interrupt Controller 0x0080 PORTCFG Port Configuration 0x0000 AES AES Module 0x0100 DMA DMA Controller 0x0100 DMA DMA Controller 0x0200 ADCA Analag to Digital Converter on port A 0x0200 ADCA Analag Converter on port A 0x0200 ACA Analag Converter on port A 0x0300 ACA Analag Converter	0x0000	GPIO	General Purpose IO Registers
0x0018 VPORT2 Virtual Port 2 0x001C VPORT3 Virtual Port 3 0x0040 CLK Clock Control 0x0040 CLK Clock Control 0x0050 OSC Oscillator Control 0x0060 DFLLRC32M DFLL for the 32 MHz Internal RC Oscillator 0x0060 DFLLRC2M DFLL for the 2 MHz C Oscillator 0x0070 PR Power Reduction 0x0080 WDT Watch-Dog Timer 0x0080 WDT Watch-Dog Timer 0x0080 WDT Watch-Dog Timer 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0010 DMA DMA Controller 0x0100 DMA DMA Controller 0x0200 ADCA Analog to Digital Converter on port A 0x0200 DACA Digital to Analog Converter on port A 0x0300 DACA Digital to Analog Converter on port B 0x0300 DACA	0x0010	VPORT0	
Ox001C VPORT3 Virtual Port 3 0x0030 CPU CPU CPU 0x0040 CLK Clock Control 0x0048 SLEEP Sleep Controller 0x0060 OSC Oscillator Control 0x0060 DFLL RC2M DFLL for the 32 MHz RC Oscillator 0x0070 PR Power Reduction 0x0080 WDT Watch-Dog Timer 0x0080 WDT Watch-Dog Timer 0x0080 PORTCFG Port Configuration 0x0080 DACA Analog to Digital Converter on port A 0x0200 ADCA Analog Converter on port A 0x0200 ADCA Analog Converter on port A 0x0300 ACA Analog Converter on port A 0x0300 ACA <	0x0014	VPORT1	Virtual Port 1
0x0030 CPU CPU 0x0048 CLK Clock Control 0x0050 OSC Oscillator Control 0x0050 DFLL RC32M DFLL for the 32 MHz Internal RC Oscillator 0x0068 DFLLRC2M DFLL for the 32 MHz Internal RC Oscillator 0x0070 PR Power Reduction 0x0080 WDT Watch-Dog Timer 0x0080 WDT Watch-Dog Timer 0x0080 MCU MCU Control 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0100 DMA DMA Controller 0x0200 ACCA Analog to Digital Converter on port A 0x0240 ADCA Analog to Digital Converter on port A 0x0330 DACA Digital to Analog Converter on port A 0x0330 ACA Analog Comparator pair on port A 0x0330 ACA Analog Comparator pair on port B	0x0018	VPORT2	Virtual Port 2
0x0040 CLK Clock Control 0x0048 SLEEP Sleep Controller 0x0060 OSC Oscillator Control 0x0068 DFLLRC2M DFLL for the 32 MHz Internal RC Oscillator 0x0070 PR Power Reduction 0x0070 PR Power Reduction 0x0070 PR Power Reduction 0x0080 WDT Watch-Dog Timer 0x0080 PORTC Programmable Multilevel Interrupt Controller 0x0080 PORTCFG Port Configuration 0x0010 DMA DMA Controller 0x0010 DMA DMA Controller 0x0100 DMA DMA Controller 0x0100 DMA DMA Controller 0x0100 NVM Non Volatile Memory (NVM) Controller 0x0120 ADCA Analog to Digital Converter on port A 0x0220 ADCB Digital to Analog Converter on port B 0x0330 ACA Analog Comparator pair on port A 0x0340 ACB Analog Comparator pair on port B 0x04400	0x001C	VPORT3	Virtual Port 3
0x0040 CLK Clock Control 0x0048 SLEEP Sleep Controller 0x0060 OSC Oscillator Control 0x0068 DFLLRC2M DFLL for the 32 MHz Internal RC Oscillator 0x0070 PR Power Reduction 0x0070 PR Power Reduction 0x0070 PR Power Reduction 0x0080 WDT Watch-Dog Timer 0x0080 MCU MCU Control 0x0080 PORTCFG Port Configuration 0x0010 DMA DMA Controller 0x0010 DMA DMA Controller 0x0100 DMA DMA Controller 0x0100 DMA DMA Controller 0x0100 NVM Non Volatile Memory (NVM) Controller 0x0200 ADCA Analog to Digital Converter on port A 0x0230 DACA Digital to Analog Converter on port A 0x0330 ACA Analog Comparator pair on port B 0x0440 RTC Real Time Counter 0x0440 RTC Real Time Counter	0x0030	CPU	CPU
0x0048 SLEEP Sleep Controller 0x0050 OSC Oscillator Control 0x0060 DFLLRC32M DFLL for the 32 MHz Internal RC Oscillator 0x0070 PR Power Reduction 0x0078 RST Reset Controller 0x0078 RST Reset Controller 0x0080 WDT Watch-Dog Timer 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0080 PORTCFG Port Configuration 0x0100 DMA DMA Controller 0x0180 EVSYS Event System 0x0120 NVM Non Volatile Memory (NVM) Controller 0x0240 ADCB Analog to Digital Converter on port A 0x0320 DACA Analog to Digital Converter on port A 0x03300 DACA Digital to Analog Converter on port B 0x0400 RTC Real Time Counter 0x0400 RTC Real Time Counter 0x0400 RTC Real Time Counter 0x0440	0x0040		Clock Control
0x0050 OSC Oscillator Control 0x0060 DFLLRC3M DFLL for the 32 MHz RC Oscillator 0x0070 PR Power Reduction 0x0070 PR Power Reduction 0x0070 RST Reset Controller 0x0070 MUT Wath-Dog Timer 0x0080 WDT Woth-Dog Timer 0x0080 PORTCFG Port Configuration 0x0000 DMA DMA controller 0x0100 DMA DMA controller 0x0100 DMA DMA controller 0x0100 NVM Non Volatile Memory (NVM) Controller 0x0100 NVM Non Volatile Gonverter on port A 0x0200 ADCA Analog to Digital Converter on port A 0x0320 DACA Digital to Analog Converter on port A 0x0380 ACA Analog Comparator pair on port A 0x0390 ACB Analog Comparator pair on port B 0x0440 EBI External Bus Interface 0x0440 TWIC Two Wire Interface on port C 0x0440	0x0048	SLEEP	Sleep Controller
0x0060 DFLLRC32M DFLL for the 32 MHz Internal RC Oscillator 0x0068 DFLLRC2M DFLL for the 2 MHz RC Oscillator 0x0070 PR Power Reduction 0x0078 RST Reset Controller 0x0080 WDT Watch-Dog Timer 0x0080 MCU MCU Control 0x0080 PORTCFG Port Configuration 0x00100 DMA DMA Controller 0x0100 DMA DMA Controller 0x0100 DMA DMA Controller 0x0100 NVM Non Volatile Memory (NVM) Controller 0x0200 ADCA Analog to Digital Converter on port A 0x0200 ADCA Analog to Digital Converter on port A 0x0200 DACA Digital to Analog Converter on port A 0x0300 DACA Analog Comparator pair on port A 0x0300 ACA Analog Comparator pair on port A 0x0390 ACB Analog Comparator pair on port A 0x0440 TWIC Two Wire Interface 0x0440 TWIC Two Wire Interface <		OSC	
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0x0080 WDT Watch-Dog Timer 0x0030 MCU MCU Control 0x0040 PMIC Programmable Multilevel Interrupt Controller 0x0080 PORTCFG Port Configuration 0x0070 AES AES Module 0x0100 DMA DMA Controller 0x0180 EVSYS Event System 0x0100 DMA Non Volatile Memory (NVM) Controller 0x0200 ADCA Analog to Digital Converter on port A 0x0200 ADCA Analog to Digital Converter on port A 0x0300 DACA Digital to Analog Converter on port B 0x0300 DACA Digital to Analog Converter on port B 0x0330 ACB Analog Comparator pair on port A 0x0340 RTC Real Time Counter 0x0440 EBI External Bus Interface 0x0440 EBI External Bus Interface 0x0440 TWID Two Wire Interface on port D 0x0440 TWIE Two Wire Interface on port E 0x0440 TWIE Two Wire Interface on port E <td></td> <td></td> <td>Reset Controller</td>			Reset Controller
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0x00B0 PORTCFG Port Configuration 0x00C0 AES AES Module 0x0100 DMA DMA Controller 0x01100 EVSYS Event System 0x0120 NVM Non Volatile Memory (NVM) Controller 0x0200 ADCA Analog to Digital Converter on port A 0x0200 DACA Digital Converter on port A 0x0300 DACA Digital to Analog Converter on port A 0x0320 DACB Digital to Analog Converter on port A 0x0380 ACA Analog Comparator pair on port A 0x0390 ACB Analog Comparator pair on port A 0x0440 Real Time Counter External Bus Interface 0x0440 TWIC Two Wire Interface on port C 0x0440 TWIE Two Wire Interface on port E 0x0440 TWIE Port A 0x0660 PORTA Port A <td></td> <td>PMIC</td> <td></td>		PMIC	
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0x0100DMADMA Controller0x0180EVSYSEvent System0x01C0NVMNon Volatile Memory (NVM) Controller0x0200ADCAAnalog to Digital Converter on port A0x0240ADCBAnalog to Digital Converter on port A0x0300DACADigital to Analog Converter on port A0x0320DACBDigital to Analog Converter on port A0x0320DACBDigital to Analog Converter on port A0x0390ACAAnalog Comparator pair on port A0x0400RTCReal Time Counter0x0440EBIExternal Bus Interface0x0440TWICTwo Wire Interface on port C0x0440TWIETwo Wire Interface on port D0x0440TWIETwo Wire Interface on port F0x0480TWIFTwo Wire Interface on port F0x0480TWIFTwo Wire Interface on port F0x0480PORTAPort A0x0620PORTBPort B0x0660PORTFPort D0x0680PORTFPort C0x0680PORTFPort B0x0680PORTFPort J0x0680PORTHPort H0x0720PORTHPort A0x0720PORTHPort R0x0720PORTRPort R0x0800TCC0Timer/Counter 0 on port C0x0800TCC1Timer/Counter 0 on port C0x0800TCC1Timer/Counter 1 on port C0x0800ACKAdvanced Waveform Extension on port C			
0x0180EVSYSEvent System0x01C0NVMNon Volatile Memory (NVM) Controller0x0200ADCAAnalog to Digital Converter on port A0x0240ADCBAnalog to Digital Converter on port B0x0300DACADigital to Analog Converter on port A0x0320DACBDigital to Analog Converter on port A0x0380ACAAnalog Comparator pair on port B0x0390ACBAnalog Comparator pair on port A0x0390ACBAnalog Comparator pair on port B0x0400RTCReal Time Counter0x0440EBIExternal Bus Interface0x0480TWICTwo Wire Interface on port C0x0480TWICTwo Wire Interface on port B0x0440TWIETwo Wire Interface on port C0x0480TWIFTwo Wire Interface on port C0x0480TWIFTwo Wire Interface on port C0x0480TWIFTwo Wire Interface on port E0x0480TWIFTwo Wire Interface on port E0x0480PORTAPort A0x0660PORTAPort B0x0660PORTCPort C0x0660PORTFPort B0x0660PORTFPort B0x0660PORTHPort F0x0680PORTFPort F0x0680PORTHPort H0x0720PORTHPort R0x0720PORTRPort Q0x0720PORTRPort R0x0800TCC0Timer/Counter 0 on port C0x0800TCC0 <t< td=""><td></td><td></td><td></td></t<>			
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0x0300DACADigital to Analog Converter on port A0x0320DACBDigital to Analog Converter on port B0x0380ACAAnalog Comparator pair on port A0x0390ACBAnalog Comparator pair on port A0x0390ACBAnalog Comparator pair on port B0x0440RTCReal Time Counter0x0440EBIExternal Bus Interface0x0440TWICTwo Wire Interface on port C0x0440TWIDTwo Wire Interface on port D0x0440TWIFTwo Wire Interface on port F0x0440TWIFTwo Wire Interface on port F0x0480TWIFTwo Wire Interface on port F0x0480TWIFPort A0x0600PORTAPort A0x0660PORTDPort B0x0660PORTDPort C0x0660PORTDPort D0x0660PORTFPort D0x0660PORTFPort F0x0660PORTFPort F0x0660PORTFPort F0x0660PORTFPort F0x0660PORTFPort F0x0700PORTJPort J0x0700PORTKPort K0x0720PORTKPort R0x0700PORTRPort R0x0800TCC1Timer/Counter 0 on port C0x0800TCC1Timer/Counter 1 on port C0x0880AWEXCAdvanced Waveform Extension on port C			
0x0320DACBDigital to Analog Converter on port B0x0380ACAAnalog Comparator pair on port A0x0390ACBAnalog Comparator pair on port B0x0400RTCReal Time Counter0x0440EBIExternal Bus Interface0x0440TWICTwo Wire Interface on port C0x0490TWIDTwo Wire Interface on port C0x0480TWIETwo Wire Interface on port E0x0480TWIFTwo Wire Interface on port F0x0480TWIFTwo Wire Interface on port F0x0600PORTAPort A0x0620PORTBPort B0x0640PORTCPort C0x0640PORTCPort C0x0660PORTFPort D0x0680PORTFPort D0x0680PORTFPort F0x0660PORTFPort F0x0660PORTFPort F0x0660PORTFPort F0x0670PORTHPort H0x0700PORTJPort J0x0720PORTKPort K0x0700PORTRPort R0x0700PORTRPort R0x0800TCC1Timer/Counter 0 on port C0x0840TCC1Timer/Counter 1 on port C0x0840AWEXCAdvanced Waveform Extension on port C			
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0x0480TWICTwo Wire Interface on port C0x0490TWIDTwo Wire Interface on port D0x04A0TWIETwo Wire Interface on port E0x04B0TWIFTwo Wire Interface on port F0x0600PORTAPort A0x0620PORTBPort B0x0660PORTCPort C0x0660PORTDPort D0x0680PORTEPort E0x0660PORTFPort F0x0660PORTFPort F0x0660PORTFPort F0x0660PORTFPort K0x0700PORTJPort J0x0720PORTKPort K0x0720PORTRPort R0x07E0PORTRPort R0x0800TCC0Timer/Counter 0 on port C0x0840TCC1Timer/Counter 1 on port C0x0880AWEXCAdvanced Waveform Extension on port C			
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0x0620PORTBPort B0x0640PORTCPort C0x0660PORTDPort D0x0680PORTEPort E0x06A0PORTFPort F0x06E0PORTHPort H0x0700PORTJPort J0x0720PORTKPort K0x07C0PORTQPort Q0x07E0PORTRPort R0x0800TCC0Timer/Counter 0 on port C0x0840TCC1Timer/Counter 1 on port C0x0880AWEXCAdvanced Waveform Extension on port C	0x04B0	TWIF	Two Wire Interface on port F
0x0640PORTCPort C0x0660PORTDPort D0x0680PORTEPort E0x06A0PORTFPort F0x06E0PORTHPort H0x0700PORTJPort J0x0720PORTKPort K0x07C0PORTQPort Q0x07E0PORTRPort R0x0800TCC0Timer/Counter 0 on port C0x0840TCC1Timer/Counter 1 on port C0x0880AWEXCAdvanced Waveform Extension on port C	0x0600	PORTA	Port A
0x0660 PORTD Port D 0x0680 PORTE Port E 0x06A0 PORTF Port F 0x06E0 PORTH Port H 0x0700 PORTJ Port J 0x0720 PORTK Port K 0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x0620	PORTB	Port B
0x0680 PORTE Port E 0x06A0 PORTF Port F 0x06E0 PORTH Port H 0x0700 PORTJ Port J 0x0720 PORTK Port K 0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x0640	PORTC	Port C
0x06A0 PORTF Port F 0x06E0 PORTH Port H 0x0700 PORTJ Port J 0x0720 PORTK Port K 0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x0660	PORTD	Port D
0x06E0 PORTH Port H 0x0700 PORTJ Port J 0x0720 PORTK Port K 0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x0680	PORTE	Port E
0x0700 PORTJ Port J 0x0720 PORTK Port K 0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x06A0	PORTF	Port F
0x0720 PORTK Port K 0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x06E0	PORTH	Port H
0x07C0 PORTQ Port Q 0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x0700	PORTJ	Port J
0x07E0 PORTR Port R 0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x0720	PORTK	Port K
0x0800 TCC0 Timer/Counter 0 on port C 0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x07C0	PORTQ	Port Q
0x0840 TCC1 Timer/Counter 1 on port C 0x0880 AWEXC Advanced Waveform Extension on port C	0x07E0	PORTR	Port R
0x0880 AWEXC Advanced Waveform Extension on port C	0x0800	TCC0	Timer/Counter 0 on port C
	0x0840	TCC1	Timer/Counter 1 on port C
0x0890 HIRESC High Resolution Extension on port C	0x0880	AWEXC	Advanced Waveform Extension on port C
	0x0890	HIRESC	High Resolution Extension on port C
0x08A0 USARTC0 USART 0 on port C	0x08A0	USARTC0	USART 0 on port C
0x08B0 USARTC1 USART 1 on port C	0x08B0	USARTC1	USART 1 on port C
0x08C0 SPIC Serial Peripheral Interface on port C	0x08C0		
0x08F8 IRCOM Infrared Communication Module	0x08F8	IRCOM	Infrared Communication Module
0x0900 TCD0 Timer/Counter 0 on port D			
0x0940 TCD1 Timer/Counter 1 on port D			
0x0990 HIRESD High Resolution Extension on port D			
0x09A0 USARTD0 USART 0 on port D			
0x09B0 USARTD1 USART 1 on port D	0x09B0	USARTD1	USART 1 on port D

Table 30-1. Peripheral Module Address Map



Base Address	Name	Description
0x09C0	SPID	Serial Peripheral Interface on port D
0x0A00	TCE0	Timer/Counter 0 on port E
0x0A40	TCE1	Timer/Counter 1 on port E
0x0A80	AWEXE	Advanced Waveform Extension on port E
0x0A90	HIRESE	High Resolution Extension on port E
0x0AA0	USARTE0	USART 0 on port E
0x0AB0	USARTE1	USART 1 on port E
0x0AC0	SPIE	Serial Peripheral Interface on port E
0x0B00	TCF0	Timer/Counter 0 on port F
0x0B40	TCF1	Timer/Counter 1 on port F
0x0B90	HIRESF	High Resolution Extension on port F
0x0BA0	USARTF0	USART 0 on port F
0x0BB0	USARTF1	USART 1 on port F
0x0BC0	SPIF	Serial Peripheral Interface on port F



31. Instruction Set Summary

Mnemonics	Operands	Description	Opera	ation		Flags	#Clocks
	<u>.</u>	Arithmeti	c and Logic Instructions				
ADD	Rd, Rr	Add without Carry	Rd	←	Rd + Rr	Z,C,N,V,S,H	1
ADC	Rd, Rr	Add with Carry	Rd	←	Rd + Rr + C	Z,C,N,V,S,H	1
ADIW	Rd, K	Add Immediate to Word	Rd	←	Rd + 1:Rd + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract without Carry	Rd	←	Rd - Rr	Z,C,N,V,S,H	1
SUBI	Rd, K	Subtract Immediate	Rd	←	Rd - K	Z,C,N,V,S,H	1
SBC	Rd, Rr	Subtract with Carry	Rd	~	Rd - Rr - C	Z,C,N,V,S,H	1
SBCI	Rd, K	Subtract Immediate with Carry	Rd	~	Rd - K - C	Z,C,N,V,S,H	1
SBIW	Rd, K	Subtract Immediate from Word	Rd + 1:Rd	~	Rd + 1:Rd - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND	Rd	←	Rd ● Rr	Z,N,V,S	1
ANDI	Rd, K	Logical AND with Immediate	Rd	~	Rd • K	Z,N,V,S	1
OR	Rd, Rr	Logical OR	Rd	←	Rd v Rr	Z,N,V,S	1
ORI	Rd, K	Logical OR with Immediate	Rd	←	Rd v K	Z,N,V,S	1
EOR	Rd, Rr	Exclusive OR	Rd	←	$Rd \oplus Rr$	Z,N,V,S	1
СОМ	Rd	One's Complement	Rd	←	\$FF - Rd	Z,C,N,V,S	1
NEG	Rd	Two's Complement	Rd	←	\$00 - Rd	Z,C,N,V,S,H	1
SBR	Rd,K	Set Bit(s) in Register	Rd	←	Rd v K	Z,N,V,S	1
CBR	Rd,K	Clear Bit(s) in Register	Rd	←	Rd • (\$FFh - K)	Z,N,V,S	1
INC	Rd	Increment	Rd	←	Rd + 1	Z,N,V,S	1
DEC	Rd	Decrement	Rd	←	Rd - 1	Z,N,V,S	1
TST	Rd	Test for Zero or Minus	Rd	←	Rd • Rd	Z,N,V,S	1
CLR	Rd	Clear Register	Rd	←	$Rd \oplus Rd$	Z,N,V,S	1
SER	Rd	Set Register	Rd	←	\$FF	None	1
MUL	Rd,Rr	Multiply Unsigned	R1:R0	~	Rd x Rr (UU)	Z,C	2
MULS	Rd,Rr	Multiply Signed	R1:R0	←	Rd x Rr (SS)	Z,C	2
MULSU	Rd,Rr	Multiply Signed with Unsigned	R1:R0	←	Rd x Rr (SU)	Z,C	2
FMUL	Rd,Rr	Fractional Multiply Unsigned	R1:R0	~	Rd x Rr<<1 (UU)	Z,C	2
FMULS	Rd,Rr	Fractional Multiply Signed	R1:R0	←	Rd x Rr<<1 (SS)	Z,C	2
FMULSU	Rd,Rr	Fractional Multiply Signed with Unsigned	R1:R0	~	Rd x Rr<<1 (SU)	Z,C	2
DES	К	Data Encryption	if (H = 0) then R15:R0 else if (H = 1) then R15:R0	← ←	Encrypt(R15:R0, K) Decrypt(R15:R0, K)		1/2
		Br	anch Instructions				
RJMP	k	Relative Jump	PC	←	PC + k + 1	None	2
IJMP		Indirect Jump to (Z)	PC(15:0) PC(21:16)	$\stackrel{\leftarrow}{\leftarrow}$	Z, 0	None	2
EIJMP		Extended Indirect Jump to (Z)	PC(15:0) PC(21:16)	← ←	Z, EIND	None	2
JMP	k	Jump	PC	~	k	None	3
RCALL	k	Relative Call Subroutine	PC	~	PC + k + 1	None	2 / 3 ⁽¹⁾
ICALL		Indirect Call to (Z)	PC(15:0) PC(21:16)	\leftarrow	Z, 0	None	2 / 3 ⁽¹⁾
EICALL		Extended Indirect Call to (Z)	PC(15:0) PC(21:16)	← ←	Z, EIND	None	3 ⁽¹⁾



Mnemonics	Operands	Description	Opera	ation		Flags	#Clocks
CALL	k	call Subroutine	PC	←	k	None	3 / 4 ⁽¹⁾
RET		Subroutine Return	PC	←	STACK	None	4 / 5 ⁽¹⁾
RETI		Interrupt Return	PC	←	STACK	I	4 / 5 ⁽¹⁾
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC	\leftarrow	PC + 2 or 3	None	1/2/3
CP	Rd,Rr	Compare	Rd - Rr			Z,C,N,V,S,H	1
CPC	Rd,Rr	Compare with Carry	Rd - Rr - C			Z,C,N,V,S,H	1
CPI	Rd,K	Compare with Immediate	Rd - K			Z,C,N,V,S,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b) = 0) PC	←	PC + 2 or 3	None	1/2/3
SBRS	Rr, b	Skip if Bit in Register Set	if (Rr(b) = 1) PC	~	PC + 2 or 3	None	1/2/3
SBIC	A, b	Skip if Bit in I/O Register Cleared	if (I/O(A,b) = 0) PC	\leftarrow	PC + 2 or 3	None	2/3/4
SBIS	A, b	Skip if Bit in I/O Register Set	If (I/O(A,b) =1) PC	←	PC + 2 or 3	None	2/3/4
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC	←	PC + k + 1	None	1/2
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 0) then PC	←	PC + k + 1	None	1/2
BREQ	k	Branch if Equal	if (Z = 1) then PC	←	PC + k + 1	None	1/2
BRNE	k	Branch if Not Equal	if (Z = 0) then PC	←	PC + k + 1	None	1/2
BRCS	k	Branch if Carry Set	if (C = 1) then PC	←	PC + k + 1	None	1/2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC	←	PC + k + 1	None	1/2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC	←	PC + k + 1	None	1/2
BRLO	k	Branch if Lower	if (C = 1) then PC	←	PC + k + 1	None	1/2
BRMI	k	Branch if Minus	if (N = 1) then PC	←	PC + k + 1	None	1/2
BRPL	k	Branch if Plus	if (N = 0) then PC	←	PC + k + 1	None	1/2
BRGE	k	Branch if Greater or Equal, Signed	if (N \oplus V= 0) then PC	←	PC + k + 1	None	1/2
BRLT	k	Branch if Less Than, Signed	if (N \oplus V= 1) then PC	←	PC + k + 1	None	1/2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC	←	PC + k + 1	None	1/2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC	←	PC + k + 1	None	1/2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC	←	PC + k + 1	None	1/2
BRTC	k	Branch if T Flag Cleared	if (T = 0) then PC	←	PC + k + 1	None	1/2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC	←	PC + k + 1	None	1/2
BRVC	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC	←	PC + k + 1	None	1/2
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then PC	←	PC + k + 1	None	1/2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC	←	PC + k + 1	None	1/2
	+	Data T	ransfer Instructions			ł	+
MOV	Rd, Rr	Copy Register	Rd	~	Rr	None	1
MOVW	Rd, Rr	Copy Register Pair	Rd+1:Rd	~	Rr+1:Rr	None	1
LDI	Rd, K	Load Immediate	Rd	←	К	None	1
LDS	Rd, k	Load Direct from data space	Rd	~	(k)	None	2 ⁽¹⁾⁽²⁾
LD	Rd, X	Load Indirect	Rd	←	(X)	None	1 ⁽¹⁾⁽²⁾
LD	Rd, X+	Load Indirect and Post-Increment	Rd X	← ←	(X) X + 1	None	1 ⁽¹⁾⁽²⁾
LD	Rd, -X	Load Indirect and Pre-Decrement	$\begin{array}{c} X \leftarrow X \text{ - } 1, \\ \text{Rd} \leftarrow (X) \end{array}$	← ←	X - 1 (X)	None	2 ⁽¹⁾⁽²⁾
LD	Rd, Y	Load Indirect	$Rd \leftarrow (Y)$	←	(Y)	None	1 ⁽¹⁾⁽²⁾
LD	Rd, Y+	Load Indirect and Post-Increment	Rd	←	(Y)	None	1 ⁽¹⁾⁽²⁾
			Y	←	Ý + 1		



Mnemonics	Operands	Description	Opera	ation		Flags	#Clocks
LD	Rd, -Y	Load Indirect and Pre-Decrement	Y Rd	$\stackrel{\leftarrow}{\leftarrow}$	Y - 1 (Y)	None	2 ⁽¹⁾⁽²⁾
LDD	Rd, Y+q	Load Indirect with Displacement	Rd	←	(Y + q)	None	2 ⁽¹⁾⁽²⁾
LD	Rd, Z	Load Indirect	Rd	←	(Z)	None	1 ⁽¹⁾⁽²⁾
LD	Rd, Z+	Load Indirect and Post-Increment	Rd Z	$\stackrel{\leftarrow}{\leftarrow}$	(Z), Z+1	None	1 ⁽¹⁾⁽²⁾
LD	Rd, -Z	Load Indirect and Pre-Decrement	Z Rd	$\stackrel{\leftarrow}{\leftarrow}$	Z - 1, (Z)	None	2 ⁽¹⁾⁽²⁾
LDD	Rd, Z+q	Load Indirect with Displacement	Rd	←	(Z + q)	None	2 ⁽¹⁾⁽²⁾
STS	k, Rr	Store Direct to Data Space	(k)	\leftarrow	Rd	None	2 ⁽¹⁾
ST	X, Rr	Store Indirect	(X)	\leftarrow	Rr	None	1 ⁽¹⁾
ST	X+, Rr	Store Indirect and Post-Increment	(X) X	← ←	Rr, X + 1	None	1 ⁽¹⁾
ST	-X, Rr	Store Indirect and Pre-Decrement	X (X)	$\leftarrow \leftarrow$	X - 1, Rr	None	2 ⁽¹⁾
ST	Y, Rr	Store Indirect	(Y)	←	Rr	None	1 ⁽¹⁾
ST	Y+, Rr	Store Indirect and Post-Increment	(Y) Y	← ←	Rr, Y + 1	None	1 ⁽¹⁾
ST	-Y, Rr	Store Indirect and Pre-Decrement	Y (Y)	← ←	Y - 1, Rr	None	2 ⁽¹⁾
STD	Y+q, Rr	Store Indirect with Displacement	(Y + q)	←	Rr	None	2 ⁽¹⁾
ST	Z, Rr	Store Indirect	(Z)	\leftarrow	Rr	None	1 ⁽¹⁾
ST	Z+, Rr	Store Indirect and Post-Increment	(Z) Z	← ←	Rr Z + 1	None	1 ⁽¹⁾
ST	-Z, Rr	Store Indirect and Pre-Decrement	Z	←	Z - 1	None	2 ⁽¹⁾
STD	Z+q,Rr	Store Indirect with Displacement	(Z + q)	←	Rr	None	2 ⁽¹⁾
LPM		Load Program Memory	R0	\leftarrow	(Z)	None	3
LPM	Rd, Z	Load Program Memory	Rd	←	(Z)	None	3
LPM	Rd, Z+	Load Program Memory and Post-Increment	Rd Z	← ←	(Z), Z + 1	None	3
ELPM		Extended Load Program Memory	R0	←	(RAMPZ:Z)	None	3
ELPM	Rd, Z	Extended Load Program Memory	Rd	←	(RAMPZ:Z)	None	3
ELPM	Rd, Z+	Extended Load Program Memory and Post- Increment	Rd Z	← ←	(RAMPZ:Z), Z + 1	None	3
SPM		Store Program Memory	(RAMPZ:Z)	←	R1:R0	None	-
SPM	Z+	Store Program Memory and Post-Increment by 2	(RAMPZ:Z) Z	$\stackrel{\leftarrow}{\leftarrow}$	R1:R0, Z + 2	None	-
IN	Rd, A	In From I/O Location	Rd	←	I/O(A)	None	1
OUT	A, Rr	Out To I/O Location	I/O(A)	~	Rr	None	1
PUSH	Rr	Push Register on Stack	STACK	←	Rr	None	1 ⁽¹⁾
POP	Rd	Pop Register from Stack	Rd	- ←	STACK	None	2 ⁽¹⁾
		Bit and Bi	t-test Instructions				
LSL	Rd	Logical Shift Left	Rd(n+1) Rd(0) C	$\begin{array}{c} \leftarrow \\ \leftarrow \\ \leftarrow \end{array}$	Rd(n), 0, Rd(7)	Z,C,N,V,H	1
LSR	Rd	Logical Shift Right	Rd(n) Rd(7) C	← ← ←	Rd(n+1), 0, Rd(0)	Z,C,N,V	1



Mnemonics	Operands	Description	Opera	tion		Flags	#Clocks
ROL	Rd	Rotate Left Through Carry	Rd(0) Rd(n+1) C	$\begin{array}{c} \downarrow \\ \downarrow \\ \downarrow \end{array}$	C, Rd(n), Rd(7)	Z,C,N,V,H	1
ROR	Rd	Rotate Right Through Carry	Rd(7) Rd(n) C	$\begin{array}{c} \downarrow \\ \downarrow \\ \downarrow \end{array}$	C, Rd(n+1), Rd(0)	Z,C,N,V	1
ASR	Rd	Arithmetic Shift Right	Rd(n)	←	Rd(n+1), n=06	Z,C,N,V	1
SWAP	Rd	Swap Nibbles	Rd(30)	\leftrightarrow	Rd(74)	None	1
BSET	s	Flag Set	SREG(s)	←	1	SREG(s)	1
BCLR	S	Flag Clear	SREG(s)	←	0	SREG(s)	1
SBI	A, b	Set Bit in I/O Register	I/O(A, b)	←	1	None	1
CBI	A, b	Clear Bit in I/O Register	I/O(A, b)	←	0	None	1
BST	Rr, b	Bit Store from Register to T	Т	←	Rr(b)	Т	1
BLD	Rd, b	Bit load from T to Register	Rd(b)	←	т	None	1
SEC		Set Carry	С	←	1	С	1
CLC		Clear Carry	С	←	0	С	1
SEN		Set Negative Flag	N	←	1	N	1
CLN		Clear Negative Flag	N	←	0	Ν	1
SEZ		Set Zero Flag	Z	←	1	Z	1
CLZ		Clear Zero Flag	Z	←	0	Z	1
SEI		Global Interrupt Enable	I	←	1	I	1
CLI		Global Interrupt Disable	I	←	0	I	1
SES		Set Signed Test Flag	S	\leftarrow	1	S	1
CLS		Clear Signed Test Flag	S	←	0	S	1
SEV		Set Two's Complement Overflow	V	←	1	V	1
CLV		Clear Two's Complement Overflow	V	←	0	V	1
SET		Set T in SREG	Т	←	1	Т	1
CLT		Clear T in SREG	Т	←	0	т	1
SEH		Set Half Carry Flag in SREG	Н	←	1	н	1
CLH		Clear Half Carry Flag in SREG	н	←	0	н	1
		МСО	Control Instructions				
BREAK		Break	(See specific des	cr. for l	BREAK)	None	1
NOP		No Operation				None	1
SLEEP		Sleep	(see specific de	scr. for	Sleep)	None	1
WDR		Watchdog Reset	(see specific de	scr. for	WDR)	None	1

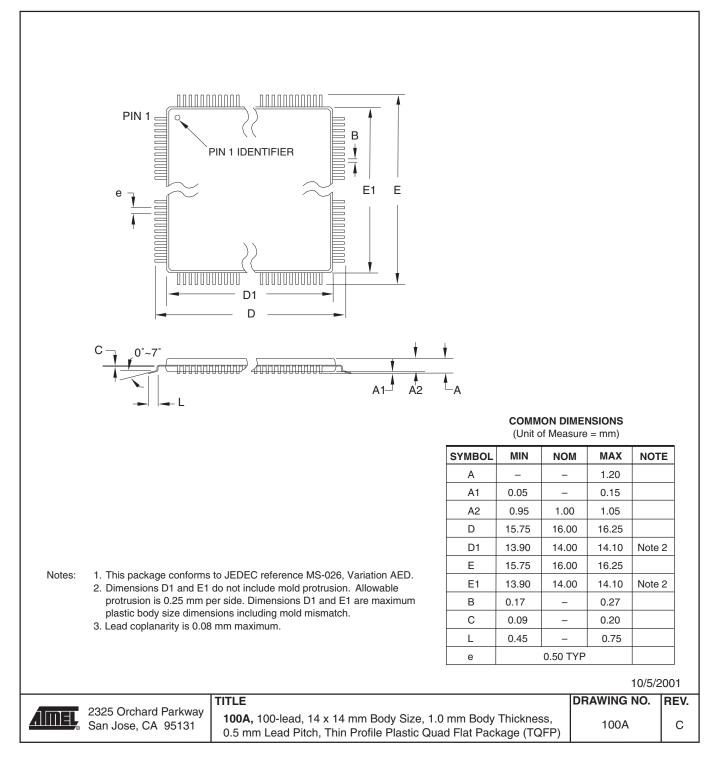
Notes: 1. Cycle times for Data memory accesses assume internal memory accesses, and are not valid for accesses via the external RAM interface.

2. One extra cycle must be added when accessing Internal SRAM.



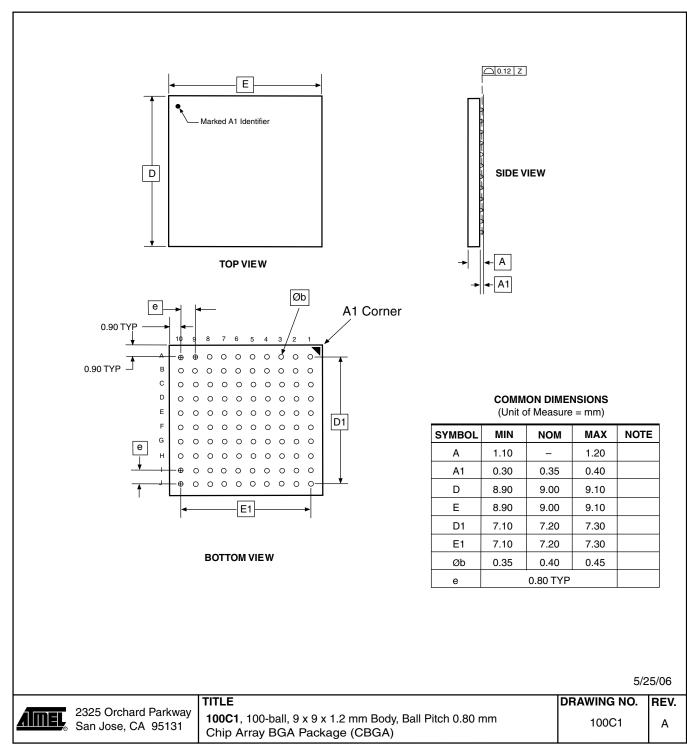
32. Packaging information

32.1 100A



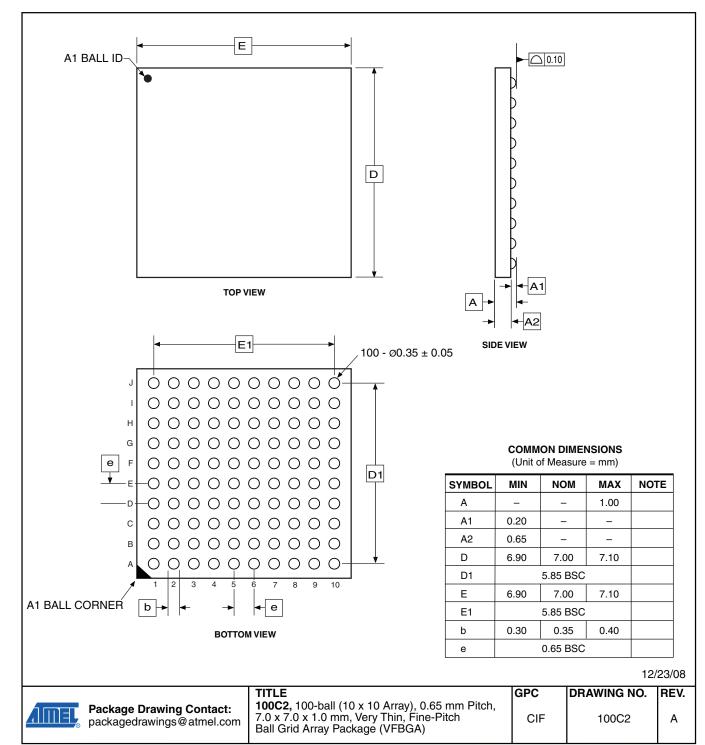


32.2 100C1





32.3 100C2





33. Electrical Characteristics

33.1 Absolute Maximum Ratings*

Operating Temperature55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on any Pin with respect to Ground0.5V to $\rm V_{\rm CC}\text{+}0.5V$
Maximum Operating Voltage 3.6V
DC Current per I/O Pin 20.0 mA
DC Current V_{CC} and GND Pins

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

33.2 DC Characteristics

Table 33-1.Current Consumption

Symbol	Parameter	Condit	ion		Min	Тур	Max	Units
-				V _{CC} = 1.8V		TBD		
			32 kHz, Ext. Clk	$V_{\rm CC} = 3.0 V$		TBD		
				V _{CC} = 1.8V		365		
		Active	1 MHz, Ext. Clk	V _{CC} = 3.0V		790		μA
				V _{CC} = 1.8V		690	800	
			2 MHz, Ext. Clk	V _{CC} = 3.0V		1400	1600	
	Device Currents Current(1)		32 MHz, Ext. Clk	$V_{\rm CC} = 3.0 V$		18.35	20	mA
	Power Supply Current ⁽¹⁾			V _{CC} = 1.8V		TBD		
		Idle	32 kHz, Ext. Clk	V _{CC} = 3.0V		TBD		μΑ
			1 MHz, Ext. Clk	V _{CC} = 1.8V		135		
				$V_{\rm CC} = 3.0 V$		255		
I _{CC}			2 MHz, Ext. Clk	V _{CC} = 1.8V		270	380	
·CC				V _{CC} = 3.0V		510	650	
			32 MHz, Ext. Clk	$V_{CC} = 3.0V$		8.15	9.2	mA
		All Functions Disabled		$V_{\rm CC} = 3.0 V$		0.1		 μΑ
		All Functions Disabled, T = 85°C		$V_{\rm CC} = 3.0 V$		2	5	
	Power-down mode	ULP, WDT, Sampled BOD		V _{CC} = 1.8V		0.5		
-				V _{CC} = 3.0V		0.6		
		ULP, WDT, Sampled BOD, T=85°C		$V_{\rm CC} = 3.0 V$		3	10	
	Power-save mode	RTC 1	kHz from Low Power 32 kHz	V _{CC} = 1.8V		0.52		_ μA
				V _{CC} = 3.0V		0.55		1
		RTC fro	om Low Power 32 kHz TOSC	$V_{\rm CC} = 3.0 V$		1.16		-
	Reset Current Consumption	without Reset pull-up resistor current		V _{CC} = 3.0V		TBD		-



Table 33-1.	Current Consumption
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Symbol	Parameter	Condition	Min	Тур	Max	Units
Module c	urrent consumption ⁽²⁾					÷
	RC32M			395		
	RC32M w/DFLL	Internal 32.768 kHz oscillator as DFLL source		TBD		
	RC2M			120		
	RC2M w/DFLL	Internal 32.768 kHz oscillator as DFLL source		155		
	RC32K			30		
	PLL	Multiplication factor = 10x		195		
	Watchdog normal mode			TBD		μΑ
	BOD Continuous mode			120		μ.,
	BOD Sampled mode			1		
	Internal 1.00 V ref			85		
	Temperature reference			80		
I _{CC}	RTC with int. 32 kHz RC as source	No prescaling		30		
	RTC with ULP as source	No prescaling		1		
	ADC	250 kS/s - Int. 1V Ref		3.6		
	DAC Normal Mode	1000 kS/s, Single channel, Int. 1V Ref		1.8		mA
	DAC Low-Power Mode	1000 KS/s, Single channel, Int. 1V Ref		1		
	AC High-speed			220		
	AC Low-power			110		
	USART	Rx and Tx enabled, 9600 BAUD		7.5		
	DMA			180		μA
	Timer/Counter	Prescaler DIV1		18		
	AES			195		1
	Flash/EEPROM	Vcc = 2V		20		ma A
	Programming	Vcc = 3V		30		mA

Note: 1. All Power Reduction Registers set. Typical numbers measured at T = 25°C if nothing else is specified.

2. All parameters measured as the difference in current consumption between module enabled and disabled. All data at $V_{CC} = 3.0V$, Clk_{SYS} = 1 MHz External clock with no prescaling, T = 25°C.



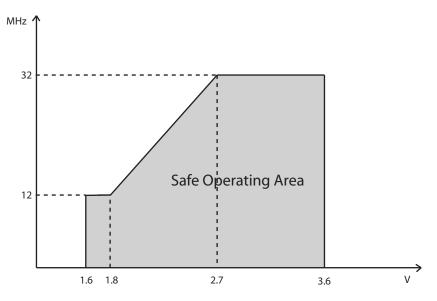
33.3 Speed

	eperaning renage and	1 ,				
Symbol	Parameter	Condition	Min	Тур	Max	Units
Clk _{CPU}	CPU clock frequency	$V_{CC} = 1.6V$	0		12	
		$V_{\rm CC} = 1.8V$	0		12	
		V _{CC} = 2.7V	0		32	MHz
		V _{CC} = 3.6V	0		32	

Table 33-2.Operating voltage and frequency

The maximum CPU clock frequency of the XMEGA A1 devices is depending on V_{CC}. As shown in Figure 33-1 on page 69 the Frequency vs. V_{CC} curve is linear between $1.8V < V_{CC} < 2.7V$.







33.4 Flash and EEPROM Memory Characteristics

Symbol	Parameter	Condition		Min	Тур	Max	Units
			25°C	10K			Quala
	Flash	Write/Erase cycles	85°C	10K			Cycle
			25°C	100			Year
		Data retention	55°C	25			
			25°C	80K			Cycle
		Write/Erase cycles	85°C	30K			
EEPR	EEPROM		25°C	100			N
	Data retention	Data retention	55°C	25			Year

Table 33-3. Endurance and Data Retention

Table 33-4.Programming time

Symbol	Parameter	Condition	Min	Typ ⁽¹⁾	Мах	Units
	Chip Erase	Flash, EEPROM ⁽²⁾ and SRAM Erase		40		
		Page Erase		6		
Flash	Page Write		6			
	Page WriteAutomatic Page Erase and Write		12		ms	
EEPROM		Page Erase		6		
	EEPROM	Page Write		6		
		Page WriteAutomatic Page Erase and Write		12		

Notes: 1. Programming is timed from the internal 2 MHz oscillator.

2. EEPROM is not erased if the EESAVE fuse is programmed.



33.5 ADC Characteristics

Symbol	Parameter	Condition	Min	Тур	Мах	Units
RES	Resolution	Programmable: 8/12	8	12	12	Bits
INL	Integral Non-Linearity	500 kS/s	-5	<±1	5	LSB
DNL	Differential Non-Linearity	500 kS/s		< ±0.75		LSB
	Gain Error			±10		mV
	Offset Error			±2		mV
ADC _{clk}	ADC Clock frequency	Max is 1/4 of Peripheral Clock			2000	kHz
	Conversion rate				2000	ksps
	Conversion time (propagation delay)	(RES+2)/2+GAIN RES = 8 or 12, GAIN = 0 or 1	5	7	2000 8 VREF V _{cc} +0.3	ADC _{clk} cycles
	Sampling Time	1/2 ADC _{clk} cycle	0.25			μS
	Conversion range		0		VREF	V
AVCC	Analog Supply Voltage		V _{cc} -0.3		V _{cc} +0.3	V
VREF	Reference voltage		1.0		V _{cc} -0.6	V
	Input bandwidth			2000		kHz
INT1V	Internal 1.00V reference			1.00		V
INTVCC	Internal V _{CC} /1.6			V _{CC} /1.6		V
SCALEDVCC	Scaled internal V _{CC} /10 input			V _{CC} /10		V
R _{AREF}	Reference input resistance			>10		MΩ
	Start-up time			12	24	ADC _{clk} cycles
	Internal input sampling speed	Temp. sensor, V _{CC} /10, Bandgap			100	ksps

 Table 33-6.
 ADC Gain Stage Characteristics

Symbol	Parameter	Condition		Min	Тур	Max	Units
	Gain error	1 to 64 gain			< ±1		%
	Offset error				< ±1		
	Noise level at input		VREF = Int. 1V		0.12		mV
Vrms		64x gain	VREF = Ext. 2V		0.06		
	Clock rate	Same as ADC				1000	kHz



33.6 DAC Characteristics

Table 33-7.	DAC Characteristics
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Symbol	Parameter	Condition		Min	Тур	Max	Units
INL	Integral Non-Linearity	$V_{CC} = 1.6-3.6V$	VREF = Ext. ref		5		
	Differential Non-Linearity		VREF = Ext. ref		0.6	<±1	LSB
DNL		V _{CC} = 1.6-3.6V	VREF= AV _{CC}		0.6		
F _{clk}	Conversion rate					1000	ksps
AREF	External reference voltage			1.1		AV _{CC} -0.6	V
	Reference input impedance				>10		MΩ
	Max output voltage	R_{load} =100k Ω			AV _{CC} *0.98		V
	Min output voltage	R_{load} =100k Ω			0.01		V
	Offset factory calibration accuracy	Continues mode, V _{CC} =3.0V, VREF = Int 1.00V, T=85°C			TBD		
	Gain factory calibration accuracy				TBD		LSB

33.7 Analog Comparator Characteristics

Table 33-8.	Analog	Comparator	Characteristics
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Symbol	Parameter	Condition		Min	Тур	Max	Units
V _{off}	Input Offset Voltage	V _{CC} = 1.6 - 3.6V			<±5		mV
I _{lk}	Input Leakage Current	V _{CC} = 1.6 - 3.6V			< 1000		pА
V _{hys1}	Hysteresis, No	V _{CC} = 1.6 - 3.6V			0		mV
V _{hys2}	Hysteresis, Small	V _{CC} = 1.6 - 3.6V	mode = HS		25		
V _{hys3}	Hysteresis, Large	V _{CC} = 1.6 - 3.6V	mode = HS		50		mV
		V _{CC} = 3.0V, T= 85°C	mode = HS			100	
t _{delay}	Propagation delay	V _{CC} = 1.6 - 3.6V	mode = HS		70		ns
		V _{CC} = 1.6 - 3.6V	mode = LP		140		

33.8 Bandgap Characteristics

Table 33-9.	Bandgap	Voltage	Characteristics
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Symbol	Parameter	Condition	Min	Тур	Max	Units
	Pondron startun tima	As reference for ADC or DAC	1 C	lk_PER + 2.5µs		
	Bandgap startup time	As input to AC or ADC		TBD		μs
	Bandgap voltage			1.1		
		T= 85°C, After calibration	0.99		1.01	V
	ADC/DAC ref			1		
	Variation over voltage and temperature	$V_{CC} = 1.6 - 3.6V$, T = -40°C to 85°C		±5		%



33.9 Brownout Detection Characteristics

Symbol	Parameter	Condition	Min	Тур	Max	Units
	BOD level 0 falling Vcc			1.6		
	BOD level 1 falling Vcc			1.9		
	BOD level 2 falling Vcc			2.1		
	BOD level 3 falling Vcc			2.4		
	BOD level 4 falling Vcc			2.6		V
	BOD level 5 falling Vcc			2.9		
	BOD level 6 falling Vcc			3.2		
	BOD level 7 falling Vcc			3.4		1
	Hysteresis	BOD level 0-5		2		%

Table 33-10. Brownout Detection Characteristics⁽¹⁾

Note: 1. BOD is calibrated to BOD level 0 at 85°C, and BOD level 0 is the default level.

33.10 PAD Characteristics

Table 33-11.PAD Characteristics

Symbol	Parameter	Condition	Min	Тур	Max	Units
V	Input Ligh Voltage	V _{CC} = 2.4 - 3.6V	0.7*V _{CC}		V _{CC} +0.5	
V _{IH}	Input High Voltage	V _{CC} = 1.6 - 2.4V	0.8*V _{CC}		V _{CC} +0.5	
N/	V _{IL} Input Low Voltage	V _{CC} = 2.4 - 3.6V	-0.5		0.3*V _{CC}	
v _{IL}		V _{CC} = 1.6 - 2.4V	-0.5		0.2*V _{CC}	
V _{OL} Output Low Voltage GPIO		I _{OH} = 15 mA, V _{CC} = 3.3V		0.45	0.76	v
	I _{OH} = 10 mA, V _{CC} = 3.0V		0.3	0.64	V	
	I _{OH} = 5 mA, V _{CC} = 1.8V		0.2	0.46		
		I _{OH} = -8 mA, V _{CC} = 3.3V	2.6	3		
V _{OH}	Output High Voltage GPIO	I _{OH} = -6 mA, V _{CC} = 3.0V	2.1	2.2		
		I _{OH} = -2 mA, V _{CC} = 1.8V	1.4	1.6		
I _{IL}	Input Leakage Current I/O pin			<0.001	1	
I _{IH}	Input Leakage Current I/O pin			<0.001	1	μA
R _P	I/O pin Pull/Buss keeper Resistor			20		1-0
R _{RST}	Reset pin Pull-up Resistor			20		kΩ
	Input hysteresis			0.5		V



33.11 POR Characteristics

	Table 33-12.	Power-on Reset	Characteristics
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Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{POT-}	POR threshold voltage falling Vcc			1		V
V _{POT+}	POR threshold voltage rising Vcc			1.4		V

33.12 Reset Characteristics

Table 33-13. Reset Characteristics	Table 33-13.	Reset Characteristics
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Symbol	Parameter	Condition	Min	Тур	Max	Units
	Minimum reset pulse width			90		ns
	Depat threshold valtage	V _{CC} = 2.7 - 3.6V		0.45*V _{CC}		V
	Reset threshold voltage	V _{CC} = 1.6 - 2.7V		0.42*V _{CC}		V

33.13 Oscillator Characteristics

Table 33-14.	Internal 32.768 kHz Oscillator Characteristics
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Symbol	Parameter	Condition	Min	Тур	Мах	Units
	Accuracy	$T = 85^{\circ}C$, $V_{CC} = 3V$, After production calibration	-0.5		0.5	%

Table 33-15. Internal 2 MHz Oscillator Characteristics

Symbol	Parameter	Condition	Min	Тур	Max	Units
	Accuracy	T = 85° C, V _{CC} = 3V, After production calibration	-1.5		1.5	%
	DFLL Calibration step size	$T = 25^{\circ}C, V_{CC} = 3V$		0.175		

Table 33-16. Internal 32 MHz Oscillator Characteristics

Symbol	Parameter	Condition	Min	Тур	Max	Units
	Accuracy	T = 85° C, V _{CC} = 3V, After production calibration	-1.5		1.5	%
	DFLL Calibration stepsize	$T = 25^{\circ}C, V_{CC} = 3V$		0.2		

Table 33-17. Internal 32 kHz, ULP Oscillator Characteristics

Symbol	Parameter	Condition	Min	Тур	Max	Units
	Output frequency 32 kHz ULP OSC	$T = 85^{\circ}C, V_{CC} = 3.0V$		26		kHz



Table 33-18. Maximum load capacitance (CL) and ESR recommendation for 32.768 kHz Crystal

Crystal CL [pF]	Max ESR [kΩ]
6.5	60
9	35

 Table 33-19.
 Device wake-up time from sleep

Symbol	Parameter	Condition ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units
	Idle Sleep, Standby and Extended Standby sleep mode Power-save and Power-down Sleep mode	Int. 32.768 kHz RC		130		
		Int. 2 MHz RC		2		
		Ext. 2 MHz Clock		2		μS
		Int. 32 MHz RC		0.17		
		Int. 32.768 kHz RC		320		
		Int. 2 MHz RC		10.3		
		Ext. 2 MHz Clock		4.5		
		Int. 32 MHz RC		5.8		1

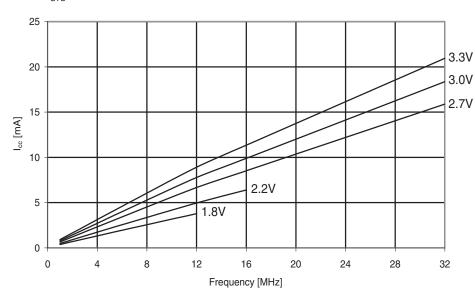
Notes: 1. Non-prescaled System Clock source.

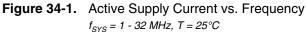
2. Time from pin change on external interrupt pin to first available clock cycle. Additional interrupt response time is minimum 5 system clock source cycles.

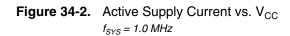


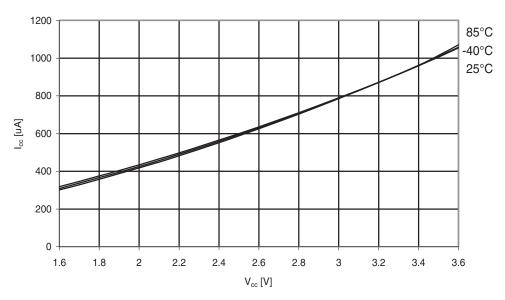
34. Typical Characteristics

34.1 Active Supply Current











34.2 Idle Supply Current

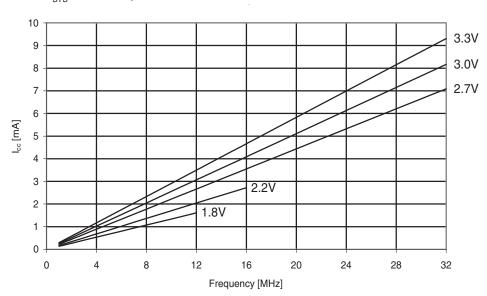
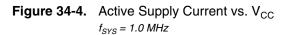
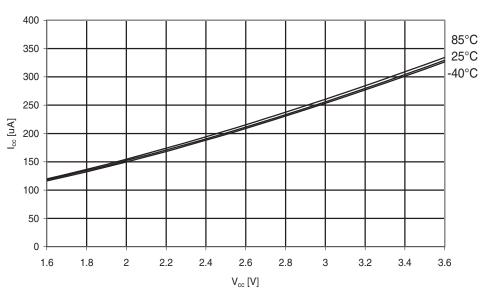


Figure 34-3. Idle Supply Current vs. Frequency $f_{SYS} = 1 - 32 \text{ MHz}, T = 25^{\circ}C$







34.3 Power-down Supply Current

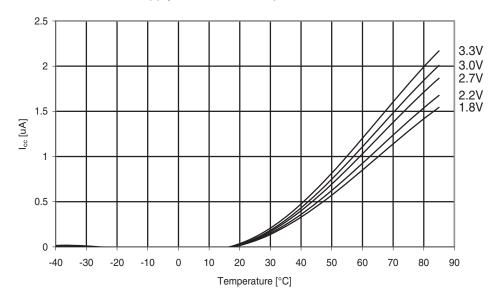
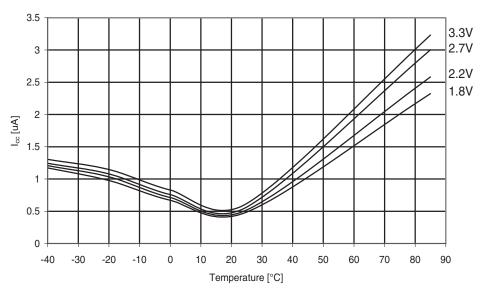


Figure 34-5. Power-down Supply Current vs. Temperature

34.4 Power-save Supply Current

 Figure 34-6.
 Power-save Supply Current vs. Temperature

 Sampled BOD, WDT, RTC from ULP enabled





34.5 Pin Pull-up

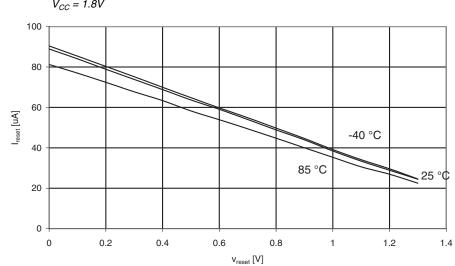
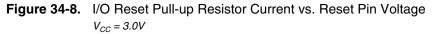
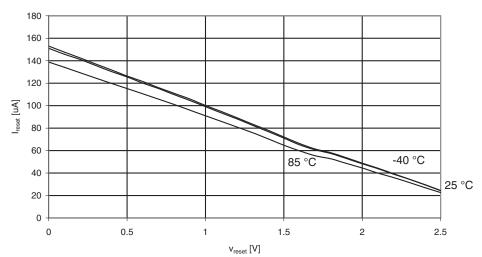


Figure 34-7. I/O Reset Pull-up Resistor Current vs. Reset Pin Voltage $V_{CC} = 1.8V$







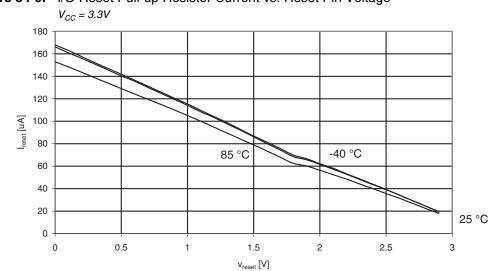
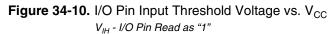
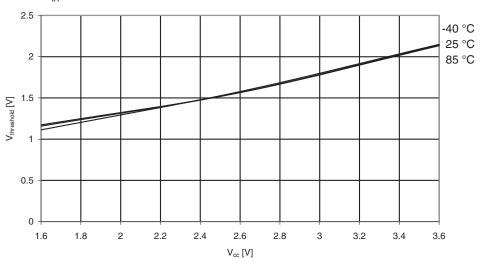


Figure 34-9. I/O Reset Pull-up Resistor Current vs. Reset Pin Voltage

34.6 Pin Thresholds and Hysteresis







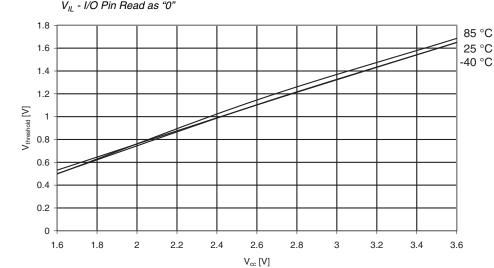
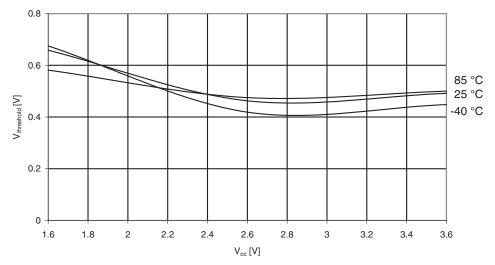


Figure 34-11. I/O Pin Input Threshold Voltage vs. V_{CC} V_{IL} - I/O Pin Read as "0"

Figure 34-12. I/O Pin Input Hysteresis vs. $V_{CC.}$





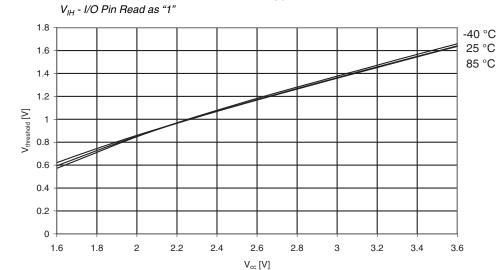
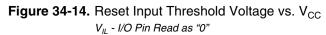
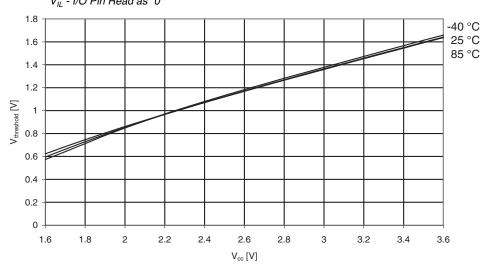


Figure 34-13. Reset Input Threshold Voltage vs. V_{CC}







34.7 Bod Thresholds

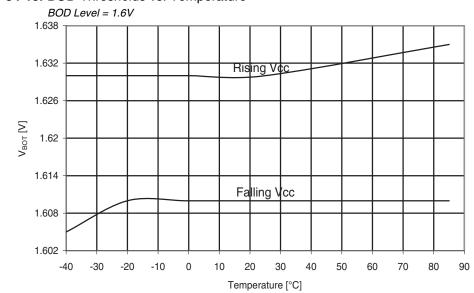
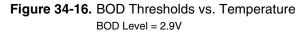
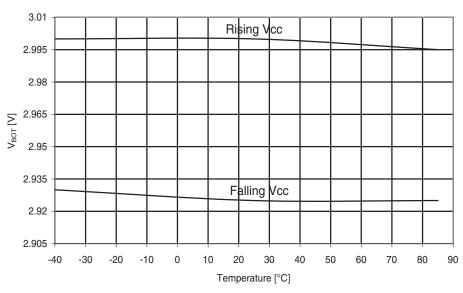


Figure 34-15. BOD Thresholds vs. Temperature







34.8 Bandgap

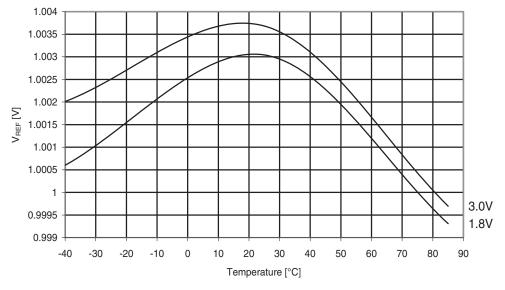
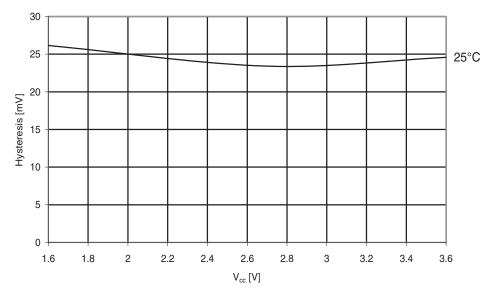


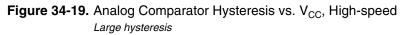
Figure 34-17. Internal 1.00V Reference vs. Temperature.

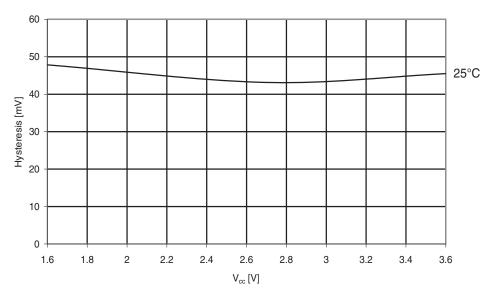
34.9 Analog Comparator

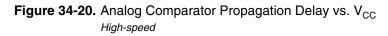
Figure 34-18. Analog Comparator Hysteresis vs. V_{CC} High-speed, Small hysteresis

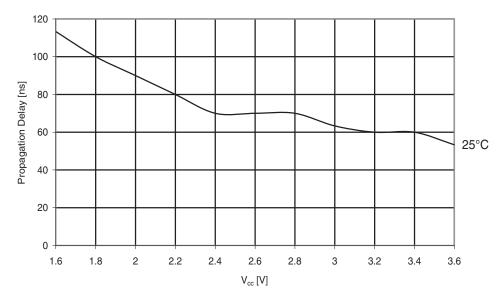














34.10 Oscillators and Wake-up Time

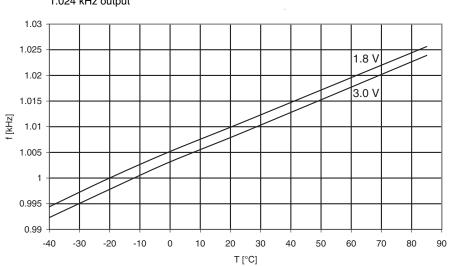
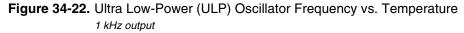
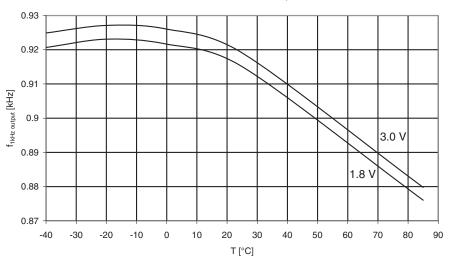


Figure 34-21. Internal 32.768 kHz Oscillator Frequency vs. Temperature 1.024 kHz output







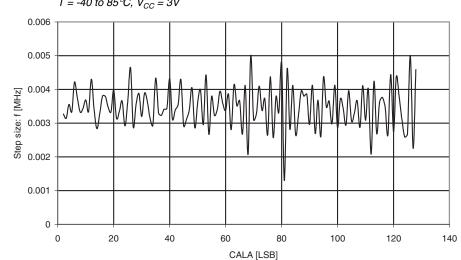
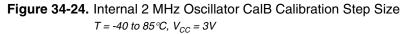
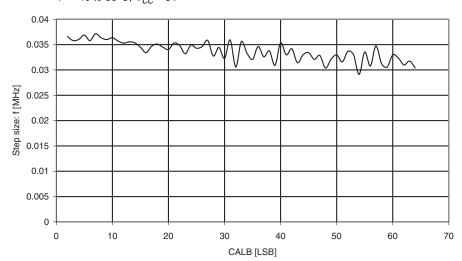


Figure 34-23. Internal 2 MHz Oscillator CalA Calibration Step Size T = -40 to 85 °C, $V_{CC} = 3V$







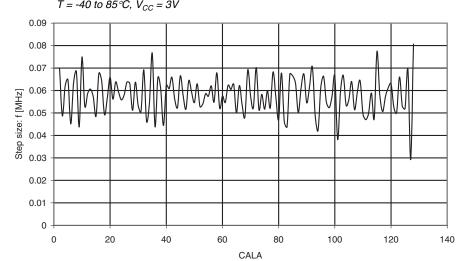
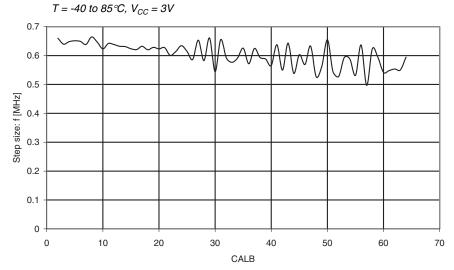


Figure 34-25. Internal 32 MHz Oscillator CalA Calibration Step Size T = -40 to 85°C, $V_{CC} = 3V$

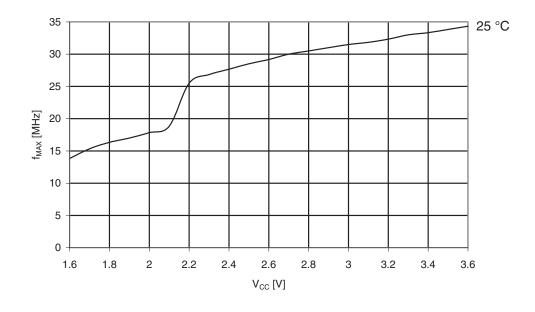
Figure 34-26. Internal 32 MHz Oscillator CalB Calibration Step Size





34.11 PDI Speed

Figure 34-27. PDI Speed vs. V_{CC}





35. Errata

35.1 ATxmega128A1 rev. H

- · Bandgap voltage input for the ACs can not be changed when used for both ACs simultaneously
- VCC voltage scaler for AC is non-linear
- The ADC has up to ±2 LSB inaccuracy
- ADC gain stage output range is limited to 2.4 V
- Sampling speed limited to 500 ksps for supply voltage below 2.0V
- ADC Event on compare match non-functional
- Bandgap measurement with the ADC is non-functional when VCC is below 2.7V
- Accuracy lost on first three samples after switching input to ADC gain stage
- The input difference between two succeeding ADC samples is limited by VREF
- Increased noise when using internal 1.0V reference at low temperature
- Configuration of PGM and CWCM not as described in XMEGA A Manual
- PWM is not restarted properly after a fault in cycle-by-cycle mode
- BOD will be enabled at any reset
- BODACT fuse location is not correct
- · Sampled BOD in Active mode will cause noise when bandgap is used as reference
- DAC has up to ±10 LSB noise in Sampled Mode
- DAC is nonlinear and inaccurate when reference is above 2.4V or VCC 0.6V
- DAC refresh may be blocked in S/H mode
- · Conversion lost on DAC channel B in event triggered mode
- · Both DFLLs and both oscillators have to be enabled for one to work
- Access error when multiple bus masters are accessing SDRAM
- EEPROM page buffer always written when NVM DATA0 is written
- · Pending full asynchronous pin change interrupts will not wake the device
- Pin configuration does not affect Analog Comparator Output
- Low level interrupt triggered when pin input is disabled
- JTAG enable does not override Analog Comparator B output
- NMI Flag for Crystal Oscillator Failure automatically cleared
- Flash Power Reduction Mode can not be enabled when entering sleep
- Some NVM Commands are non-functional
- · Crystal start-up time required after power-save even if crystal is source for RTC
- Setting PRHIRES bit makes PWM output unavailable
- · Accessing EBI address space with PREBI set will lock Bus Master
- RTC Counter value not correctly read after sleep
- · Pending asynchronous RTC-interrupts will not wake up device
- TWI, the minimum I2C SCL low time could be violated in Master Read mode
- TWI address-mask feature is non-functional
- TWI, a general address call will match independent of the R/W-bit value
- TWI Transmit collision flag not cleared on repeated start
- Clearing TWI Stop Interrupt Flag may lock the bus
- TWI START condition at bus timeout will cause transaction to be dropped
- TWI Data Interrupt Flag erroneously read as set
- · WDR instruction inside closed window will not issue reset



1. Bandgap voltage input for the ACs cannot be changed when used for both ACs simultaneously

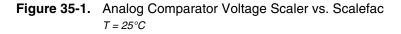
If the Bandgap voltage is selected as input for one Analog Comparator (AC) and then selected/deselected as input for another AC, the first comparator will be affected for up to 1 μ s and could potentially give a wrong comparison result.

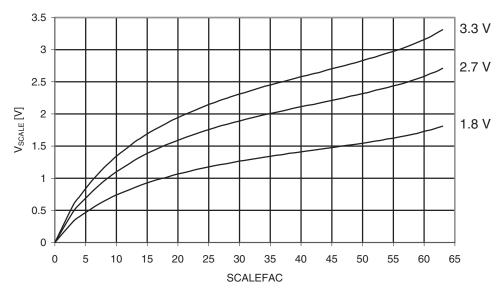
Problem fix/Workaround

If the Bandgap is required for both ACs simultaneously, configure the input selection for both ACs before enabling any of them.

2. VCC voltage scaler for AC is non-linear

The 6-bit VCC voltage scaler in the Analog Comparators is non-linear.





Problem fix/Workaround

Use external voltage input for the analog comparator if accurate voltage levels are needed

3. The ADC has up to ±2 LSB inaccuracy

The ADC will have up to ± 2 LSB inaccuracy, visible as a saw-tooth pattern on the input voltage/ output value transfer function of the ADC. The inaccuracy increases with increasing voltage reference reaching ± 2 LSB with 3V reference.

Problem fix/Workaround

None, the actual ADC resolution will be reduced with up to ± 2 LSB.

4. ADC gain stage output range is limited to 2.4 V

The amplified output of the ADC gain stage will never go above 2.4 V, hence the differential input will only give correct output when below 2.4 V/gain. For the available gain settings, this gives a differential input range of:



-	1x	gain:	2.4	V
-	2x	gain:	1.2	V
-	4x	gain:	0.6	V
-	8x	gain:	300	mV
-	16x	gain:	150	mV
-	32x	gain:	75	mV
-	64x	gain:	38	mV

Problem fix/Workaround

Keep the amplified voltage output from the ADC gain stage below 2.4 V in order to get a correct result, or keep ADC voltage reference below 2.4 V.

5. Sampling speed limited to 500 ksps for supply voltage below 2.0V

The sampling frequency is limited to 500 ksps for supply voltage below 2.0V. At higher sampling rate the INL error will be several hundred LSB.

Problem fix/Workaround

None.

6. ADC Event on compare match non-functional

ADC signalling event will be given at every conversion complete even if Interrupt mode (INT-MODE) is set to BELOW or ABOVE.

Problem fix/Workaround

Enable and use interrupt on compare match when using the compare function.

7. Bandgap measurement with the ADC is non-functional when VCC is below 2.7V The ADC can not be used to do bandgap measurements when VCC is below 2.7V.

Problem fix/Workaround

None.

8. Accuracy lost on first three samples after switching input to ADC gain stage

Due to memory effect in the ADC gain stage, the first three samples after changing input channel must be disregarded to achieve 12-bit accuracy.

Problem fix/Workaround

Run three ADC conversions and discard these results after changing input channels to ADC gain stage.

9. The input difference between two succeeding ADC samples is limited by VREF

If the difference in input between two samples changes more than the size of the reference, the ADC will not be able to convert the data correctly. Two conversions will be required before the conversion is correct.

Problem fix/Workaround

Discard the first conversion if input is changed more than VREF, or ensure that the input never changes more then VREF.



10. Increased noise when using internal 1.0V reference at low temperature

When operating at below 0°C and using internal 1.0V reference the RMS noise will be up 4 LSB, Peak-to-peak noise up to 25 LSB.

Problem fix/Workaround

Use averaging to remove noise.

11. Configuration of PGM and CWCM not as described in XMEGA A Manual

Enabling Common Waveform Channel Mode will enable Pattern generation mode (PGM), but not Common Waveform Channel Mode.

Enabling Pattern Generation Mode (PGM) and not Common Waveform Channel Mode (CWCM) will enable both Pattern Generation Mode and Common Waveform Channel Mode.

Problem fix/Workaround

PGM	CWCM	Description
0	0	PGM and CWCM disabled
0	1	PGM enabled
1	0	PGM and CWCM enabled
1	1	PGM enabled

110010111	
Table 35-1.	Configure PWM and CWCM according to this table:

12 PWM is not restarted properly after a fault in cycle-by-cycle mode

When the AWeX fault restore mode is set to cycle-by-cycle, the waveform output will not return to normal operation at first update after fault condition is no longer present.

Problem fix/Workaround

Do a write to any AWeX I/O register to re-enable the output.

13. BOD will be enabled after any reset

If any reset source goes active, the BOD will be enabled and keep the device in reset if the VCC voltage is below the programmed BOD level. During Power-On Reset, reset will not be released until VCC is above the programmed BOD level even if the BOD is disabled.

Problem fix/Workaround

Do not set the BOD level higher than VCC even if the BOD is not used.

14. BODACT fuse location is not correct

The fuses for enabling BOD in active mode (BODACT) are located at FUSEBYTE2, bit 2 and 3 and not in FUSEBYTE 5 as described in the XMEGA A Manual..

Problem fix/Workaround

Access the fuses in FUSEBYTE2.

15. Sampled BOD in Active mode will cause noise when bandgap is used as reference

Using the BOD in sampled mode when the device is running in Active or Idle mode will add noise on the bandgap reference for ADC, DAC and Analog Comparator.

Problem fix/Workaround

If the bandgap is used as reference for either the ADC, DAC or Analog Comparator, the BOD must not be set in sampled mode.



16. DAC has up to ±10 LSB noise in Sampled Mode

The DAC has noise of up to ± 10 LSB in Sampled Mode for entire operation range.

Problem fix/Workaround

Use the DAC in continuous mode.

17. DAC is nonlinear and inaccurate when reference is above 2.4V or VCC - 0.6V

Using the DAC with a reference voltage above 2.4V or VCC - 0.6V will give inaccurate output when converting codes that give below 0.75V output:

 $-\pm 10$ LSB for continuous mode

- ±200 LSB for Sample and Hold mode

Problem fix/Workaround

None.

18. DAC has up to ±10 LSB noise in Sampled Mode

If the DAC is running in Sample and Hold (S/H) mode and conversion for one channel is done at maximum rate (i.e. the DAC is always busy doing conversion for this channel), this will block refresh signals to the second channel.

Problem fix/Workaround

When using the DAC in S/H mode, ensure that none of the channels is running at maximum conversion rate, or ensure that the conversion rate of both channels is high enough to not require refresh.

19. Conversion lost on DAC channel B in event triggered mode

If during dual channel operation channel 1 is set in auto trigged conversion mode, channel 1 conversions are occasionally lost. This means that not all data-values written to the Channel 1 data register are converted.

Problem fix/Workaround

Keep the DAC conversion interval in the range 000-001 (1 and 3 CLK), and limit the Peripheral clock frequency so the conversion internal never is shorter than $1.5 \,\mu s$.

20. Both DFLLs and both oscillators have to be enabled for one to work

In order to use the automatic runtime calibration for the 2 MHz or the 32 MHz internal oscillators, the DFLL for both oscillators and both oscillators have to be enabled for one to work.

Problem fix/Workaround

Enable both DFLLs and both oscillators when using automatic runtime calibration for either of the internal oscillators.

21. Access error when multiple bus masters are accessing SDRAM

If one bus master (CPU and DMA channels) is using the EBI to access an SDRAM in burst mode and another bus master is accessing the same row number in a different BANK of the SDRAM in the cycle directly after the burst access is complete, the access for the second bus master will fail.

Problem fix/Workaround

Do not put stack pointer in SDRAM and use DMA Controller in 1 byte burst mode if CPU and DMA Controller are required to access SDRAM at the same time.



22. EEPROM page buffer always written when NVM DATA0 is written

If the EEPROM is memory mapped, writing to NVM DATA0 will corrupt data in the EEPROM page buffer.

Problem fix/Workaround

Before writing to NVM DATA0, for example when doing software CRC or flash page buffer write, check if EEPROM page buffer active loading flag (EELOAD) is set. Do not write NVM DATA0 when EELOAD is set.

23. Pending full asynchronous pin change interrupts will not wake the device

Any full asynchronous pin-change Interrupt from pin 2, on any port, that is pending when the sleep instruction is executed, will be ignored until the device is woken from another source or the source triggers again. This applies when entering all sleep modes where the System Clock is stopped.

Problem fix/Workaround

None.

24. Pin configuration does not affect Analog Comparator Output

The Output/Pull and inverted pin configuration does not affect the Analog Comparator output function.

Problem fix/Workaround

None for Output/Pull configuration.

For inverted I/O, configure the Analog Comparator to give an inverted result (i.e. connect positive input to the negative AC input and vice versa), or use and external inverter to change polarity of Analog Comparator output.

25. Low level interrupt triggered when pin input is disabled

If a pin input is disabled, but pin is configured to trigger on low level, interrupt request will be sent.

Problem fix/Workaround

Ensure that Interrupt mask for the disabled pin is cleared.

26. JTAG enable does not override Analog Comparator B output

When JTAG is enabled this will not override the Analog Comparator B (ACB) output, AC0OUT on pin 7 if this is enabled.

Problem fix/Workaround

Use Analog Comparator output for ACA when JTAG is used, or use the PDI as debug interface.

27. NMI Flag for Crystal Oscillator Failure automatically cleared

NMI flag for Crystal Oscillator Failure (XOSCFDIF) will be automatically cleared when executing the NMI interrupt handler.

Problem fix/Workaround

This device revision has only one NMI interrupt source, so checking the interrupt source in software is not required.



28. Flash Power Reduction Mode can not be enabled when entering sleep

If Flash Power Reduction Mode is enabled when entering Power-save or Extended Standby sleep mode, the device will only wake up on every fourth wake-up request. If Flash Power Reduction Mode is enabled when entering Idle sleep mode, the wake-up time will vary with up to 16 CPU clock cycles.

Problem fix/Workaround

Disable Flash Power Reduction mode before entering sleep mode.

29. Some NVM Commands are non-functional

The following NVM commands are non-functional:

- 0x2B Erase Flash Page
- 0x2E Write Flash Page
- 0x2F Erase & Write Flash Page
- 0x3A Flash Range CRC

Problem fix/Workaround

None for Flash Range CRC

Use separate programming commands for accessing application and boot section.

- 0x22 Erase Application Section Page
- 0x24 Write Application Section Page
- 0x25 Erase & Write Application Section Page
- 0x2A Erase Boot Loader Section Page
- 0x2C Write Boot Loader Section Page
- 0x2D Erase & Write Boot Loader Section Page
- 30. Crystal start-up time required after power-save even if crystal is source for RTC

Even if 32.768 kHz crystal is used for RTC during sleep, the clock from the crystal will not be ready for the system before the specified start-up time. See "XOSCSEL[3:0]: Crystal Oscillator Selection" in XMEGA A Manual. If BOD is used in active mode, the BOD will be on during this period (0.5s).

Problem fix/Workaround

If faster start-up is required, go to sleep with internal oscillator as system clock.

31. Setting PRHIRES bit makes PWM output unavailable

Setting the HIRES Power Reduction (PR) bit for PORTx will make any Frequency or PWM output for the corresponding Timer/Counters (TCx0 and TCx1) unavailable on the pin even if the Hi-Res is not used.

Problem fix/Workaround

Do not write the HIRES PR bit on PORTx when frequency or PWM output from TCx0/1 is used.

32. Accessing EBI address space with PREBI set will lock Bus Master



If EBI Power Reduction Bit is set while EBI is enabled, accessing external memory could result in bus hang-up, blocking all further access to all data memory.

Problem fix/Workaround

Ensure that EBI is disabled before setting EBI Power Reduction bit.

33. RTC Counter value not correctly read after sleep

If the RTC is set to wake up the device on RTC Overflow and bit 0 of RTC CNT is identical to bit 0 of RTC PER as the device is entering sleep, the value in the RTC count register can not be read correctly within the first prescaled RTC clock cycle after wakeup. The value read will be the same as the value in the register when entering sleep.

The same applies if RTC Compare Match is used as wake-up source.

Problem fix/Workaround

Wait at least one prescaled RTC clock cycle before reading the RTC CNT value.

34. Pending asynchronous RTC-interrupts will not wake up device

Asynchronous Interrupts from the Real-Time-Counter that is pending when the sleep instruction is executed, will be ignored until the device is woken from another source or the source triggers again.

Problem fix/Workaround

None.

35. TWI, the minimum I²C SCL low time could be violated in Master Read mode

If the TWI is in Master Read mode and issues a Repeated Start on the bus, this will immediately release the SCL line even if one complete SCL low period has not passed. This means that the minimum SCL low time in the I2C specification could be violated.

Problem fix/Workaround

If this is a problem in the application, ensure in software that the Repeated Start is never issued before one SCL low time has passed.

36. TWI address-mask feature is non-functional

The address-mask feature is non-functional, so the TWI can not perform hardware address match on more than one address.

Problem fix/Workaround

If the TWI must respond to multiple addresses, enable Promiscuous Mode for the TWI to respond to all address and implement the address-mask function in software.

37. TWI, a general address call will match independent of the R/W-bit value

When the TWI is in Slave mode and a general address call is issued on the bus, the TWI Slave will get an address match regardless of the received R/W bit.

Problem fix/Workaround

Use software to check the R/W-bit on general call address match.

38. TWI Transmit collision flag not cleared on repeated start

The TWI transmit collision flag should be automatically cleared on start and repeated start, but is only cleared on start.



Problem fix/Workaround

Clear the flag in software after address interrupt.

39. Clearing TWI Stop Interrupt Flag may lock the bus

If software clears the STOP Interrupt Flag (APIF) on the same Peripheral Clock cycle as the hardware sets this flag due to a new address received, CLKHOLD is not cleared and the SCL line is not released. This will lock the bus.

Problem fix/Workaround

Check if the bus state is IDLE. If this is the case, it is safe to clear APIF. If the bus state is not IDLE, wait for the SCL pin to be low before clearing APIF.

Code:

```
/* Only clear the interrupt flag if within a "safe zone". */
while ( /* Bus not IDLE: */
       ((COMMS_TWI.MASTER.STATUS & TWI_MASTER_BUSSTATE_gm) !=
         TWI_MASTER_BUSSTATE_IDLE_gc)) &&
         /* SCL not held by slave: */
         ! (COMMS_TWI.SLAVE.STATUS & TWI_SLAVE_CLKHOLD_bm)
      )
{
    /* Ensure that the SCL line is low */
    if ( !(COMMS_PORT.IN & PIN1_bm) )
        if ( !(COMMS_PORT.IN & PIN1_bm) )
            break;
}
/* Check for an pending address match interrupt */
if ( !(COMMS_TWI.SLAVE.STATUS & TWI_SLAVE_CLKHOLD_bm) )
{
    /* Safely clear interrupt flag */
    COMMS_TWI.SLAVE.STATUS |= (uint8_t)TWI_SLAVE_APIF_bm;
}
```

40. TWI START condition at bus timeout will cause transaction to be dropped

If Bus Timeout is enabled and a timeout occurs on the same Peripheral Clock cycle as a START is detected, the transaction will be dropped.

Problem fix/Workaround

None.

41. TWI Data Interrupt Flag erroneously read as set

When issuing the TWI slave response command CMD=0b11, it takes 1 Peripheral Clock cycle to clear the data interrupt flag (DIF). A read of DIF directly after issuing the command will show the DIF still set.

Problem fix/Workaround

Add one NOP instruction before checking DIF.



42. WDR instruction inside closed window will not issue reset

When a WDR instruction is execute within one ULP clock cycle after updating the window control register, the counter can be cleared without giving a system reset.

Problem fix/Workaround

Wait at least one ULP clock cycle before executing a WDR instruction.



35.2 ATxmega128A1 rev. G

- Bootloader Section in Flash is non-functional
- Bandgap voltage input for the ACs cannot be changed when used for both ACs simultaneously
- DAC is nonlinear and inaccurate when reference is above 2.4V
- ADC gain stage output range is limited to 2.4 V
- The ADC has up to ±2 LSB inaccuracy
- TWI, a general address call will match independent of the R/W-bit value
- TWI, the minimum I²C SCL low time could be violated in Master Read mode
- Setting HIRES PR bit makes PWM output unavailable
- EEPROM erase and write does not work with all System Clock sources
- BOD will be enabled after any reset
- Propagation delay analog Comparator increasing to 2 ms at -40°C
- Sampled BOD in Active mode will cause noise when bandgap is used as reference
- Default setting for SDRAM refresh period too low
- Flash Power Reduction Mode can not be enabled when entering sleep mode
- Enabling Analog Comparator B output will cause JTAG failure
- JTAG enable does not override Analog Comparator B output
- + Bandgap measurement with the ADC is non-functional when $\rm V_{\rm CC}$ is below 2.7V
- DAC refresh may be blocked in S/H mode
- Inverted I/O enable does not affect Analog Comparator Output
- Both DFLLs and both oscillators has to be enabled for one to work

1. Bootloader Section in Flash is non-functional

The Bootloader Section is non-functional, and bootloader or application code cannot reside in this part of the Flash.

Problem fix/Workaround

None, do not use the Bootloader Section.

2. Bandgap voltage input for the ACs cannot be changed when used for both ACs simultaneously

If the Bandgap voltage is selected as input for one Analog Comparator (AC) and then selected/deselected as input for the another AC, the first comparator will be affected for up to 1 us and could potentially give a wrong comparison result.

Problem fix/Workaround

If the Bandgap is required for both ACs simultaneously, configure the input selection for both ACs before enabling any of them.

3. DAC is nonlinear and inaccurate when reference is above 2.4V

Using the DAC with a reference voltage above 2.4V give inaccurate output when converting codes that give below 0.75V output:

- ±20 LSB for continuous mode
- ±200 LSB for Sample and Hold mode

Problem fix/Workaround

None, avoid using a voltage reference above 2.4V.



4. ADC gain stage output range is limited to 2.4 V

The amplified output of the ADC gain stage will never go above 2.4 V, hence the differential input will only give correct output when below 2.4 V/gain. For the available gain settings, this gives a differential input range of:

-	1x	gain:	2.4	V
-	2x	gain:	1.2	V
-	4x	gain:	0.6	V
-	8x	gain:	300	mV
_	16x	gain:	150	mV
_	32x	gain:	75	mV
-	64x	gain:	38	mV

Problem fix/Workaround

Keep the amplified voltage output from the ADC gain stage below 2.4 V in order to get a correct result, or keep ADC voltage reference below 2.4 V.

5. The ADC has up to ±2 LSB inaccuracy

The ADC will have up to ± 2 LSB inaccuracy, visible as a saw-tooth pattern on the input voltage/ output value transfer function of the ADC. The inaccuracy increases with increasing voltage reference reaching ± 2 LSB with 3V reference.

Problem fix/Workaround

None, the actual ADC resolution will be reduced with up to ± 2 LSB.

6. TWI, a general address call will match independent of the R/W-bit value

When the TWI is in Slave mode and a general address call is issued on the bus, the TWI Slave will get an address match regardless of the R/W-bit (ADDR[0] bit) value in the Slave Address Register.

Problem fix/Workaround

Use software to check the R/W-bit on general call address match.

7. TWI, the minimum I²C SCL low time could be violated in Master Read mode

When the TWI is in Master Read mode and issuing a Repeated Start on the bus, this will immediately release the SCL line even if one complete SCL low period has not passed. This means that the minimum SCL low time in the I²C specification could be violated.

Problem fix/Workaround

If this causes a potential problem in the application, software must ensure that the Repeated Start is never issued before one SCL low time has passed.

8. Setting HIRES PR bit makes PWM output unavailable

Setting the HIRES Power Reduction (PR) bit for PORTx will make any Frequency or PWM output for the corresponding Timer/Counters (TCx0 and TCx1) unavailable on the pin.

Problem fix/Workaround

Do not write the HIRES PR bit on PORTx when frequency or PWM output from TCx0/1 is used.



9. EEPROM erase and write does not work with all System Clock sources

When doing EEPROM erase or Write operations with other clock sources than the 2 MHz RCOSC, Flash will be read wrongly for one or two clock cycles at the end of the EEPROM operation.

Problem fix/Workaround

Alt 1: Use the internal 2 MHz RCOSC when doing erase or write operations on EEPROM.

Alt 2: Ensure to be in sleep mode while completing erase or write on EEPROM. After starting erase or write operations on EEPROM, other interrupts should be disabled and the device put to sleep.

10. BOD will be enabled after any reset

If any reset source goes active, the BOD will be enabled and keep the device in reset if the VCC voltage is below the programmed BOD level. During Power-On Reset, reset will not be released until VCC is above the programmed BOD level even if the BOD is disabled.

Problem fix/Workaround

Do not set the BOD level higher than VCC even if the BOD is not used.

11. Propagation delay analog Comparator increasing to 2 ms at -40 °C

When the analog comparator is used at temperatures reaching down to -40 $^{\circ}$ C, the propagation delay will increase to ~2 ms.

Problem fix/Workaround

None

12. Sampled BOD in Active mode will cause noise when bandgap is used as reference

Using the BOD in sampled mode when the device is running in Active or Idle mode will add noise on the bandgap reference for ADC and DAC.

Problem fix/Workaround

If the bandgap is used as reference for either the ADC or the DAC, the BOD must not be set in sampled mode.

13. Default setting for SDRAM refresh period too low

If the SDRAM refresh period is set to a value less then 0x20, the SDRAM content may be corrupted when accessing through On-Chip Debug sessions.

Problem fix/Workaround

The SDRAM refresh period (REFRESHH/L) should not be set to a value less then 0x20.

14. Flash Power Reduction Mode can not be enabled when entering sleep mode

If Flash Power Reduction Mode is enabled when entering Power-save or Extended Standby sleep mode, the device will only wake up on every fourth wake-up request.

If Flash Power Reduction Mode is enabled when entering Idle sleep mode, the wake-up time will vary with up to 16 CPU clock cycles.

Problem fix/Workaround

Disable Flash Power Reduction mode before entering sleep mode.



15. JTAG enable does not override Analog Comparator B output

When JTAG is enabled this will not override the Anlog Comparator B (ACB)ouput, AC0OUT on pin 7 if this is enabled.

Problem fix/Workaround

AC0OUT for ACB should not be enabled when JTAG is used. Use only analog comparator output for ACA when JTAG is used, or use the PDI as debug interface.

16. Bandgap measurement with the ADC is non-functional when V_{cc} is below 2.7V

The ADC cannot be used to do bandgap measurements when V_{CC} is below 2.7V.

Problem fix/Workaround

If internal voltages must be measured when V_{CC} is below 2.7V, measure the internal 1.00V reference instead of the bandgap.

17. DAC refresh may be blocked in S/H mode

If the DAC is running in Sample and Hold (S/H) mode and conversion for one channel is done at maximum rate (i.e. the DAC is always busy doing conversion for this channel), this will block refresh signals to the second channel.

Problem fix/Workarund

When using the DAC in S/H mode, ensure that none of the channels is running at maximum conversion rate, or ensure that the conversion rate of both channels is high enough to not require refresh.

18. Inverted I/O enable does not affect Analog Comparator Output

The inverted I/O pin function does not affect the Analog Comparator output function.

Problem fix/Workarund

Configure the analog comparator setup to give a inverted result (i.e. connect positive input to the negative AC input and vice versa), or use and externel inverter to change polarity of Analog Comparator Output.

19. Both DFLLs and both oscillators has to be enabled for one to work

In order to use the automatic runtime calibration for the 2 MHz or the 32 MHz internal oscillators, the DFLL for both oscillators and both oscillators has to be enabled for one to work.

Problem fix/Workarund

Enabled both DFLLs and oscillators when using automatic runtime calibration for one of the internal oscillators.



36. Datasheet Revision History

Please note that the referring page numbers in this section are referred to this document. The referring revision in this section are referring to the document revision.

36.1 8067M - 09/10

1. Updated Errata "ATxmega128A1 rev. H" on page 90

36.2 8067L - 08/10

- 1. Removed Footnote 3 of Figure 2-1 on page 3
- 2. Updated "Features" on page 27. Event Channel 0 output on port pin 7
- 3. Updated "DC Characteristics" on page 67, by adding Icc for Flash/EEPROM Programming.
- 4. Added AVCC in "ADC Characteristics" on page 71.
- 5. Updated Start up time in "ADC Characteristics" on page 71.
- 6. Updated "DAC Characteristics" on page 72. Removed DC output impedence.
- 7. Fixed typo in "Packaging information" section.
- 8. Fixed typo in "Errata" section.

36.3 8067K - 02/10

1. Added "PDI Speed vs. VCC" on page 89.

36.4 8067J - 02/10

- 1. Removed JTAG Reset from the datasheet.
- 2. Updated "Timer/Counter and AWEX functions" on page 50.
- 3. Updated "Alternate Pin Functions" on page 51.
- 3. Updated all "Electrical Characteristics" on page 67.
- 4. Updated "PAD Characteristics" on page 73.
- 5. Changed Internal Oscillator Speed to "Oscillators and Wake-up Time" on page 86.
- 6. Updated "Errata" on page 90



36.5 8067I - 04/09

- 1. Updated "Ordering Information" on page 2.
- 2. Updated "PAD Characteristics" on page 73.

36.6 8067H - 04/09

- 1. Editorial updates.
- 2. Updated "Overview" on page 48.
- 3. Updated Table 29-9 on page 54.
- 4. Updated "Peripheral Module Address Map" on page 58. IRCOM has address map: 0x08F8.
- 5. Updated "Electrical Characteristics" on page 67.
- 6. Updated "PAD Characteristics" on page 73.
- 7. Updated "Typical Characteristics" on page 76.

36.7 8067G - 11/08

- 1. Updated "Block Diagram" on page 6.
- 2. Updated feature list in "Memories" on page 10.
- 3. Updated "PDI Program and Debug Interface" on page 48.
- 4. Updated "Peripheral Module Address Map" on page 58. IRCOM has address 0x8F0.
- 5. Added "Electrical Characteristics" on page 67.
- 6. Added "Typical Characteristics" on page 76.
- 7. Added "ATxmega128A1 rev. H" on page 90.
- 8. Updated "ATxmega128A1 rev. G" on page 100.

36.8 8067F - 09/08

- 1. Updated "Features" on page 1
- 2. Updated "Ordering Information" on page 2
- 3. Updated Figure 7-1 on page 11 and Figure 7-2 on page 11.
- 4. Updated Table 7-2 on page 15.
- 5. Updated "Features" on page 41 and "Overview" on page 41.
- 6. Removed "Interrupt Vector Summary" section from datasheet.

36.9 8067E - 08/08

- 1. Changed Figure 2-1's title to "Block diagram and pinout" on page 3.
- 2. Updated Figure 2-2 on page 4.
- 3. Updated Table 29-2 on page 51 and Table 29-3 on page 52.

36.10 8067D - 07/08

- 1. Updated "Ordering Information" on page 2.
- 2. Updated "Peripheral Module Address Map" on page 58.
- 3. Inserted "Interrupt Vector Summary" on page 56.

36.11 8067C - 06/08

- 1. Updated the Front page and "Features" on page 1.
- 2. Updated the "DC Characteristics" on page 67.
- 3. Updated Figure 3-1 on page 6.
- 4. Added "Flash and EEPROM Page Size" on page 15.
- 5. Updated Table 33-6 on page 71 with new data: Gain Error, Offset Error and Signal -to-Noise Ratio (SNR).
- 6. Updated Errata "ATxmega128A1 rev. G" on page 100.

36.12 8067B - 05/08

- 1. Updated "Pinout/Block Diagram" on page 3 and "Pinout and Pin Functions" on page 49.
- 2. Added XMEGA A1 Block Diagram, Figure 3-1 on page 6.
- 3. Updated "Overview" on page 5 included the XMEGA A1 explanation text on page 6.
- 4. Updated AVR CPU "Features" on page 8.
- 5. Updated Event System block diagram, Figure 9-1 on page 18.
- 6. Updated "PMIC Programmable Multi-level Interrupt Controller" on page 25.
- 7. Updated "AC Analog Comparator" on page 44.
- 8. Updated "Alternate Pin Function Description" on page 49.
- 9. Updated "Alternate Pin Functions" on page 51.
- 10. Updated "Typical Characteristics" on page 76.
- 11. Updated "Ordering Information" on page 2.
- 12. Updated "Overview" on page 5.



- 13. Updated Figure 6-1 on page 8.
- 14. Inserted a new Figure 15-1 on page 32.
- 15. Updated Speed grades in "Speed" on page 69.
- 16. Added a new ATxmega384A1 device in "Features" on page 1, updated "Ordering Information" on page 2 and "Memories" on page 10.
- 17. Replaced the Figure 3-1 on page 6 by a new XMEGA A1 detailed block diagram.
- 18. Inserted Errata "ATxmega128A1 rev. G" on page 100.

36.13 8067A - 02/08

1. Initial revision.



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